bq27520-G3

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System-Side Impedance Track™ Fuel Gauge With Integrated LDO

Check for Samples: bq27520-G3

1 INTRODUCTION

1.1 FEATURES

- Battery Fuel Gauge for 1-Series Li-Ion Applications up to 32-Ahr capacity
- Resides on System Main Board
 - Works With Embedded or Removable Battery Packs
- Uses PACK+, PACK-, and T Battery Terminals
- Microcontroller Peripheral Provides:
 - Accurate Battery Fuel Gauging
 - Internal Temperature Sensor for Battery Temperature Reporting
 - Battery Low Interrupt Warning
 - Battery Insertion Indicator
 - Configurable Level of State of Charge (SOC) Interrupts
 - State of Health Indicator
 - Current Data Logging Buffer
 - 32 Bytes of Non-Volatile Scratch-Pad FLASH
- Battery Fuel Gauge Based on Patented Impedance Track[™] Technology
 - Models the Battery Discharge Curve for Accurate Time-to-Empty Predictions
 - Automatically Adjusts for Battery Aging, Battery Self-Discharge, and Temperature/Rate Inefficiencies
 - Low-Value Sense Resistor (10 mΩ or Less)
- 400-kHz I²C[™] Interface for Connection to System Microcontroller Port
- In a 15-Pin NanoFree[™] (CSP) Packaging

1.2 APPLICATIONS

- Smartphones
- Digital Still and Video Cameras
- Handheld Terminals
- . MP3 or Multimedia Players

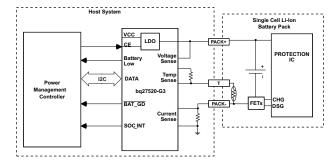
1.3 DESCRIPTION

The Texas Instruments bq27520-G3 system-side Lilon battery fuel gauge is a microcontroller peripheral that provides fuel gauging for single-cell Li-lon battery packs. The device requires little system microcontroller firmware development. The bq27520-G3 resides on the system's main board and manages an embedded battery (non-removable) or a removable battery pack.

The bq27520-G3 uses the patented Impedance Track™ algorithm for fuel gauging, and provides information such as remaining battery capacity (mAh), state-of-charge (%), run-time to empty (min), battery voltage (mV), temperature (°C) and state of health (%).

Battery fuel gauging with the bq27520-G3 requires only PACK+ (P+), PACK- (P-), and optional Thermistor (T) connections to a removable battery pack or embedded battery circuit. The CSP option is a 15-ball package in the nominal dimensions of 2610 \times 1956 μm with 0,5 mm lead pitch. It is ideal for space constrained applications.

Typical Application



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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DEVICE INFORMATION

Available Options

| PART NUMBER | PACKAGE ⁽¹⁾ | T _A | COMMUNICATION FORMAT | TAPE and REEL QUANTITY |
|----------------|------------------------|----------------|----------------------|------------------------|
| bq27520YZFR-G3 | CCD 45 | 40°C to 05°C | I ² C | 3000 |
| bq27520YZFT-G3 | CSP-15 | –40°C to 85°C | 1-0 | 250 |

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

Thermal Information 2.2

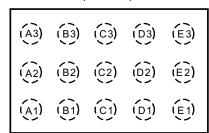
| | THERMAL METRIC ⁽¹⁾ | bq27520-G3 | LINIT |
|------------------|--|---------------|-------|
| | THERMAL METRIC | YZF (15 PINS) | UNIT |
| θ_{JA} | Junction-to-ambient thermal resistance | 70 | |
| θ_{JCtop} | Junction-to-case (top) thermal resistance | 17 | |
| θ_{JB} | Junction-to-board thermal resistance | 20 | °C/M |
| Ψ_{JT} | Junction-to-top characterization parameter | 1 | °C/W |
| ΨЈВ | Junction-to-board characterization parameter | 18 | |
| θ_{JCbot} | Junction-to-case (bottom) thermal resistance | n/a | |

⁽¹⁾ For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953

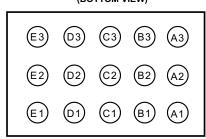
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2.3 **Pin Assignment**

CSP-15 (TOP VIEW)



CSP-15 (BOTTOM VIEW)





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Table 2-1. Pin Functions

| PIN | I | TVD=(1) | DECORPORTION | | | | |
|-----------------|--------|---------|---|--|--|--|--|
| NAME NO. | | IYPE | DESCRIPTION | | | | |
| SRP | A1 | IA | Analog input pin connected to the internal coulomb counter with a Kelvin connection where SRP is nearest the PACK– connection. Connect to 5-m Ω to 20-m Ω sense resistor. | | | | |
| SRN | B1 | IA | Analog input pin connected to the internal coulomb counter with a Kelvin connection where SRN is nearest the Vss connection. Connect to $5\text{-m}\Omega$ to $20\text{-m}\Omega$ sense resistor. | | | | |
| V _{SS} | C1, C2 | Р | Device ground | | | | |
| V _{CC} | D1 | Р | Regulator output and bq27520-G3 processor power. Decouple with 1µF ceramic capacitor to Vss. | | | | |
| REGIN | E1 | Р | Regulator input. Decouple with 0.1µF ceramic capacitor to Vss. | | | | |
| SOC_INT | A2 | 0 | SOC state interrupts output. Generates a pulse under the conditions specified by Table 5-8. Open drain output. | | | | |
| BAT_GD | B2 | 0 | Battery-good indicator. Active-low by default, though polarity can be configured through the [BATG_POL] bit of <i>Operation Configuration</i> . Push-pull output. | | | | |
| CE | D2 | 1 | Chip Enable. Internal LDO is disconnected from REGIN when driven low. | | | | |
| BAT | E2 | I | Cell-voltage measurement input. ADC input. Recommend 4.8V maximum for conversion accuracy. | | | | |
| SCL | А3 | Τ | Slave l^2C serial communications clock input line for communication with system (Master). Open-drain I/O. Use with $10k\Omega$ pull-up resistor (typical). | | | | |
| SDA | В3 | I/O | Slave l^2 C serial communications data line for communication with system (Master). Open-drain I/O. Use with $10k\Omega$ pull-up resistor (typical). | | | | |
| BAT_LOW | С3 | 0 | Battery Low output indicator. Active <i>high</i> by default, though polarity can be configured through the [BATL_POL] bit of <i>Operation Configuration</i> . Push-pull output. | | | | |
| TS | D3 | IA | Pack thermistor voltage sense (use 103AT-type thermistor). ADC input. | | | | |
| BI/TOUT | E3 | I/O | Battery-insertion detection input. Power pin for pack thermistor network. Thermistor-multiplexer control pin. Use with pull-up resistor >1 $M\Omega$ (1.8 $M\Omega$ typical). | | | | |

⁽¹⁾ I/O = Digital input/output, IA = Analog input, P = Power connection



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ELECTRICAL SPECIFICATIONS

3.1 **Absolute Maximum Ratings**

over operating free-air temperature range (unless otherwise noted)(1)

| | PARAMETER | VALUE | UNIT |
|------------------|---|--------------------------|------|
| V_{REGIN} | Regulator input range | -0.3 to 5.5 | V |
| V _{CC} | Supply voltage range | -0.3 to 2.75 | V |
| V_{IOD} | Open-drain I/O pins (SDA, SCL, SOC_INT) | -0.3 to 5.5 | V |
| V_{BAT} | BAT input pin | -0.3 to 5.5 | |
| V_{I} | Input voltage range to all other pins (BI/TOUT, TS, SRP, SRN, BAT_GD) | -0.3 to $V_{CC} + 0.3$ | V |
| ESD | Human-body model (HBM), BAT pin | 1.5 | kV |
| ESD | Human-body model (HBM), all other pins | 2 | KV |
| T _A | Operating free-air temperature range | -40 to 85 | °C |
| T _F | Functional temperature range | -40 to 100 | °C |
| T _{stg} | Storage temperature range | -65 to 150 | °C |

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Recommended Operating Conditions

 $T_A = 25$ °C and $V_{REGIN} = V_{BAT} = 3.6$ V (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------|---|--|-------------------------|-----|-----------------------|------|
| | Complex on the ma | No operating restrictions | 2.7 | | 4.5 | V |
| V_{REGIN} | Supply voltage | No FLASH writes | 2.45 | | 2.7 | V |
| C _{REGIN} | External input capacitor for internal LDO between REGIN and V _{SS} | Nominal capacitor values specified. Recommend a 5% ceramic X5R type | | 0.1 | | μF |
| C _{LDO25} | External output capacitor for internal LDO between V_{CC} and V_{SS} | capacitor located close to the device. | 0.47 | 1 | | μF |
| I _{cc} | Normal operating-mode current ⁽¹⁾ | Fuel gauge in NORMAL mode. I _{LOAD} > Sleep Current | | 118 | | μΑ |
| I _{SLP+} | Sleep+ operating mode current ⁽¹⁾ | Fuel gauge in SLEEP+ mode. I _{LOAD} < <i>Sleep Current</i> | | 62 | | μΑ |
| I _{SLP} | Low-power storage-mode current ⁽¹⁾ | Fuel gauge in SLEEP mode. I _{LOAD} < <i>Sleep Current</i> | | 23 | | μΑ |
| I _{HIB} | Hibernate operating-mode current ⁽¹⁾ | Fuel gauge in HIBERNATE mode. I _{LOAD} < <i>Hibernate Current</i> | | 8 | | μΑ |
| V _{OL} | Output voltage, low (SCL, SDA, SOC_INT, BAT_LOW) | I _{OL} = 3 mA | | | 0.4 | V |
| V _{OH(PP)} | Output voltage, high (BAT_LOW, BAT_GD) | $I_{OH} = -1 \text{ mA}$ | V _{CC} - 0.5 | | | V |
| V _{OH(OD)} | Output voltage, high (SDA, SCL, SOC_INT) | External pullup resistor connected to V _{CC} | V _{CC} - 0.5 | | | V |
| M | Input voltage, low (SDA, SCL) | | -0.3 | | 0.6 | |
| V_{IL} | Input voltage, low (BI/TOUT) | BAT INSERT CHECK mode active | -0.3 | | 0.6 | V |
| ., | Input voltage, high (SDA, SCL) | | 1.2 | | 6 | V |
| $V_{IH(OD)}$ | Input voltage, high (BI/TOUT) | BAT INSERT CHECK mode active | 1.2 | | V _{CC} + 0.3 | |
| V _{A1} | Input voltage range (TS) | | V _{SS} - 0.125 | | 2 | V |
| V _{A2} | Input voltage range (BAT) | | V _{SS} - 0.125 | | 5 | V |
| V _{A3} | Input voltage range (SRP, SRN) | | V _{SS} - 0.125 | | 0.125 | V |
| I _{lkg} | Input leakage current (I/O pins) | | | | 0.3 | μA |
| t _{PUCD} | Power-up communication delay | | | 250 | | ms |

(1) Specified by design. Not production tested.

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Power-On Reset

 $T_A = -40$ °C to 85°C, typical values at $T_A = 25$ °C and $V_{REGIN} = 3.6$ V (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------|---|-----------------|------|------|------|------|
| V_{IT+} | Positive-going battery voltage input at V _{CC} | | 2.09 | 2.20 | 2.31 | V |
| V_{HYS} | Power-on reset hysteresis | | 45 | 115 | 185 | mV |

2.5-V LDO Regulator

 $T_A = 25^{\circ}C$, $C_{1,DO25} = 1\mu F$, $V_{REGIN} = 3.6V$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIO | N | MIN | NOM | MAX | UNIT |
|------------------------|--|--|--|------|------|------|------|
| 2.5 V LDO Re | egulator ⁽¹⁾ | | | | | , | |
| | | 2.7V ≤ V _{REGIN} ≤ 4.5V, I _{OUT} ≤ 16mA | $T_A = -40$ °C to 85°C | 2.4 | 2.5 | 2.54 | V |
| V _{REG25} | Regulator output voltage | $2.45V \le V_{REGIN} < 2.7V$ (low battery), $I_{OUT} \le 3mA$ | $T_A = -40^{\circ} \text{C to } 85^{\circ} \text{C}$ | 2.4 | | | V |
| V _{IH(CE)} | CE High-level input voltage | | | 2.65 | | | V |
| V _{IL(CE)} | CE Low-level input voltage | VREGIN = 2.7 to 4.5V | $T_A = -40^{\circ}C$ to 85°C | | | 0.8 | V |
| | Descriptor drawart valtage | 2.7V, I _{OUT} ≤ 16mA | $T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ | | | 325 | >/ |
| V_{DO} | Regulator dropout voltage | 2.45V, I _{OUT} ≤ 3mA | $T_A = -40$ °C to 85°C | | | 50 | mV |
| $\Delta V_{REGTEMP}$ | Regulator output change with temperature | V _{REGIN} = 3.6V, I _{OUT} = 16mA | $T_A = -40^{\circ}\text{C to } 85^{\circ}\text{C}$ | | 0.5% | | |
| $\Delta V_{REGLINE}$ | Line regulation | 2.7V ≤ V _{REGIN} ≤ 4.5V, I _{OUT} = 16mA | | | 18 | 40 | mV |
| A\/ | | $0.2\text{mA} \le I_{\text{OUT}} \le 3\text{mA}, V_{\text{REGIN}} = 2.45 \text{ V}$ $3\text{mA} \le I_{\text{OUT}} \le 16\text{mA}, V_{\text{REGIN}} = 2.7 \text{ V}$ | | | 34 | 40 | \/ |
| $\Delta V_{REGLOAD}$ | Load regulation | | | | 31 | | mV |
| I _{SHORT} (2) | Short circuit current limit | V _{REG25} = 0V | $T_A = -40$ °C to 85°C | | | 250 | mA |

 ⁽¹⁾ LDO output current, I_{OUT}, is the total load current. LDO regulator should be used to power internal fuel gauge only.
 (2) Assured by design. Not production tested.

Internal Temperature Sensor Characteristics

 $T_A = -40$ °C to 85°C, 2.4 V < V_{CC} < 2.6 V; typical values at $T_A = 25$ °C and $V_{CC} = 2.5$ V (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------|---------------------------------|-----------------|-----|-----|-----|-------|
| G _{TEMP} | Temperature sensor voltage gain | | | -2 | | mV/°C |

High-Frequency Oscillator

 $T_A = -40$ °C to 85°C, 2.4 V < V_{CC} < 2.6 V; typical values at $T_A = 25$ °C and $V_{CC} = 2.5$ V (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|------------------------------------|------------------------------|-------|-------|------|------|
| f _{OSC} | Operating frequency | | | 2.097 | | MHz |
| | | T _A = 0°C to 60°C | -2% | 0.38% | 2% | |
| f _{EIO} | Frequency error ⁽¹⁾ (2) | $T_A = -20$ °C to 70°C | -3% | 0.38% | 3% | |
| | | $T_A = -40$ °C to 85°C | -4.5% | 0.38% | 4.5% | |
| t _{SXO} | Start-up time ⁽³⁾ | | | 2.5 | 5 | ms |

The frequency error is measured from 2.097 MHz.

The frequency drift is included and measured from the trimmed frequency at $V_{CC} = 2.5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

The start-up time is defined as the time it takes for the oscillator output frequency to be within ±3% of typical oscillator frequency.

3.7 Low-Frequency Oscillator

 $T_A = -40$ °C to 85°C, 2.4 V < V_{CC} < 2.6 V; typical values at $T_A = 25$ °C and $V_{CC} = 2.5$ V (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------|------------------------------------|---------------------------|-------|--------|------|------|
| f_{LOSC} | Operating frequency | | | 32.768 | | kHz |
| | | $T_A = 0$ °C to 60 °C | -1.5% | 0.25% | 1.5% | |
| f_{LEIO} | Frequency error ⁽¹⁾ (2) | $T_A = -20$ °C to 70 °C | -2.5% | 0.25% | 2.5% | |
| | | $T_A = -40$ °C to 85°C | -4% | 0.25% | 4% | |
| t _{LSXO} | Start-up time ⁽³⁾ | | | | 500 | μs |

⁽¹⁾ The frequency drift is included and measured from the trimmed frequency at $V_{CC} = 2.5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

3.8 Integrating ADC (Coulomb Counter) Characteristics

 $T_A = -40^{\circ}$ C to 85°C, 2.4 V < V_{CC} < 2.6 V; typical values at $T_A = 25^{\circ}$ C and $V_{CC} = 2.5$ V (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|----------------------|--|----------------------------------|--------|--------|--------|-------|
| V _{SR} | Input voltage range, V _(SRN) and V _(SRP) | $V_{SR} = V_{(SRN)} - V_{(SRP)}$ | -0.125 | | 0.125 | V |
| t _{SR_CONV} | Conversion time | Single conversion | | 1 | | S |
| | Resolution | | 14 | | 15 | bits |
| V _{OS(SR)} | Input offset | | | 10 | | μV |
| INL | Integral nonlinearity error | | | ±0.007 | ±0.034 | % FSR |
| Z _{IN(SR)} | Effective input resistance ⁽¹⁾ | | 2.5 | | | МΩ |
| I _{lkg(SR)} | Input leakage current ⁽¹⁾ | | | | 0.3 | μΑ |

⁽¹⁾ Specified by design. Not tested in production.

3.9 ADC (Temperature and Cell Measurement) Characteristics

 $T_A = -40$ °C to 85°C, 2.4 V < V_{CC} < 2.6 V; typical values at $T_A = 25$ °C and $V_{CC} = 2.5$ V (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------|---|---------------------------------------|------|-----|-----|------|
| V _{IN(ADC)} | Input voltage range | | 0.05 | | 1 | V |
| t _{ADC_CONV} | Conversion time | | | | 125 | ms |
| | Resolution | | 14 | | 15 | bits |
| V _{OS(ADC)} | Input offset | | | 1 | | mV |
| Z _{ADC1} | Effective input resistance (TS) ⁽¹⁾ | | 8 | | | ΜΩ |
| 7 | Effective input resistance (BAT) ⁽¹⁾ | bq27520-G3 not measuring cell voltage | 8 | | | ΜΩ |
| Z _{ADC2} | Effective input resistance (BAT) | bq27520-G3 measuring cell voltage | | 100 | | kΩ |
| I _{lkg(ADC)} | Input leakage current ⁽¹⁾ | | | | 0.3 | μΑ |

(1) Specified by design. Not tested in production.

⁽²⁾ The frequency error is measured from 32.768 kHz.

⁽³⁾ The start-up time is defined as the time it takes for the oscillator output frequency to be within ±3% of typical oscillator frequency.

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3.10 Data Flash Memory Characteristics

 $T_A = -40$ °C to 85°C, 2.4 V < V_{CC} < 2.6 V; typical values at $T_A = 25$ °C and $V_{CC} = 2.5$ V (unless otherwise noted)

| 7.1 | , 00 , 11 | 7 00 (| | | , | |
|-----------------------|--|-----------------|--------|-----|-----|--------|
| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| t _{DR} | Data retention ⁽¹⁾ | | 10 | | | Years |
| | Flash-programming write cycles (1) | | 20,000 | | | Cycles |
| t _{WORDPROG} | Word programming time ⁽¹⁾ | | | | 2 | ms |
| I _{CCPROG} | Flash-write supply current ⁽¹⁾ | | | 5 | 10 | mA |
| t _{DFERASE} | Data flash master erase time ⁽¹⁾ | | 200 | | | ms |
| t _{IFERASE} | Instruction flash master erase time ⁽¹⁾ | | 200 | | | ms |
| t _{PGERASE} | Flash page erase time ⁽¹⁾ | | 20 | | | ms |

⁽¹⁾ Specified by design. Not production tested

I²C-Compatible Interface Communication Timing Characteristics

 $T_A = -40$ °C to 85°C, 2.4 V < V_{CC} < 2.6 V; typical values at $T_A = 25$ °C and $V_{CC} = 2.5$ V (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------|--------------------------------------|-----------------|-----|-----|-----|------|
| t _r | SCL/SDA rise time | | | | 300 | ns |
| t _f | SCL/SDA fall time | | | | 300 | ns |
| t _{w(H)} | SCL pulse duration (high) | | 600 | | | ns |
| t _{w(L)} | SCL pulse duration (low) | | 1.3 | | | μs |
| t _{su(STA)} | Setup for repeated start | | 600 | | | ns |
| t _{d(STA)} | Start to first falling edge of SCL | | 600 | | | ns |
| t _{su(DAT)} | Data setup time | | 100 | | | ns |
| t _{h(DAT)} | Data hold time | | 0 | | | ns |
| t _{su(STOP)} | Setup time for stop | | 600 | | | ns |
| t _(BUF) | Bus free time between stop and start | | 66 | | | μs |
| f _{SCL} | Clock frequency | | | | 400 | kHz |

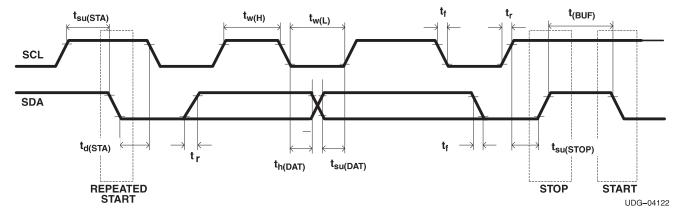


Figure 3-1. I²C-Compatible Interface Timing Diagrams



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GENERAL DESCRIPTION

The bq27520-G3 accurately predicts the battery capacity and other operational characteristics of a single Li-based rechargeable cell. It can be interrogated by a system processor to provide cell information, such as time-to-empty (TTE) and state-of-charge (SOC) as well as SOC interrupt signal to the host.

Information is accessed through a series of commands, called Standard Commands. Further capabilities are provided by the additional Extended Commands set, Both sets of commands, indicated by the general format Command(), are used to read and write information contained within the device control and status registers, as well as its data flash locations. Commands are sent from system to gauge using the bq27520-G3's I²C serial communications engine, and can be executed during application development, pack manufacture, or end-equipment operation.

Cell information is stored in the device in non-volatile flash memory. Many of these data flash locations are accessible during application development. They cannot, generally, be accessed directly during endequipment operation. Access to these locations is achieved by either use of the bq27520-G3's companion evaluation software, through individual commands, or through a sequence of data-flash-access commands. To access a desired data flash location, the correct data flash subclass and offset must be known.

The bq27520-G3 provides a 32-byte user-programmable data flash *Manufacturer Info Block*. This data space is accessed through a data flash interface. For specifics on accessing the data flash, see Section 4.3: MANUFACTURER INFORMATION BLOCK.

The key to the bq27520-G3's high-accuracy gas gauging prediction is Texas Instrument's proprietary Impedance Track™ algorithm. This algorithm uses cell measurements, characteristics, and properties to create state-of-charge predictions that can achieve less than 1% error across a wide variety of operating conditions and over the lifetime of the battery.

The device measures charge/discharge activity by monitoring the voltage across a small-value series sense resistor (5 m Ω to 20 m Ω typ.) located between the system's Vss and the battery's PACK- terminal. When a cell is attached to the device, cell impedance is learned, based on cell current, cell open-circuit voltage (OCV), and cell voltage under loading conditions.

The device external temperature sensing is optimized with the use of a high accuracy negative temperature coefficient (NTC) thermistor with R25 = 10.0kΩ ±1%. B25/85 = 3435K ± 1% (such as Semitec NTC 103AT). Alternatively, the bq27520-G3 can also be configured to use its internal temperature sensor or receive temperature data from the host processor. When an external thermistor is used, a 18.2k pull up resistor between BT/TOUT and TS pins is also required. The bg27520-G3 uses temperature to monitor the battery-pack environment, which is used for fuel gauging and cell protection functionality.

To minimize power consumption, the device has different power modes: NORMAL, SLEEP+, SLEEP, HIBERNATE, and BAT INSERT CHECK. The bq27520-G3 passes automatically between these modes, depending upon the occurrence of specific events, though a system processor can initiate some of these modes directly. More details can be found in see Section 5.7, POWER MODES.

NOTE FORMATTING CONVENTIONS IN THIS DOCUMENT:

Commands: italics with parentheses and no breaking spaces, e.g., RemainingCapacity()

Data flash: italics, bold, and breaking spaces, e.g., Design Capacity

Register bits and flags: brackets and italics, e.g., [TDA] Data flash bits: brackets, italics and bold, e.g., [LED1] Modes and states: ALL CAPITALS, e.g., UNSEALED mode.

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Data Commands

4.1.1 Standard Data Commands

The bq27520-G3 uses a series of 2-byte standard commands to enable system reading and writing of battery information. Each standard command has an associated command-code pair, as indicated in Table 4-1. Because each command consists of two bytes of data, two consecutive I²C transmissions must be executed both to initiate the command function, and to read or write the corresponding two bytes of data. Additional options for transferring data, such as spooling, are described in Section of Communication. Standard commands are accessible in NORMAL operation. Read/Write permissions depend on the active access mode, SEALED or UNSEALED (for details on the SEALED and UNSEALED states, see Section 4.4, Access Modes.)

Table 4-1. Standard Commands

| NAME | | COMMAND CODE | UNITS | SEALED ACCESS |
|--------------------------------|-------|--------------|---------|------------------|
| Control() | CNTL | 0x00 / 0x01 | N/A | R/W |
| AtRate() | AR | 0x02 / 0x03 | mA | R/W |
| AtRateTimeToEmpty() | ARTTE | 0x04 / 0x05 | Minutes | R |
| Temperature() | TEMP | 0x06 / 0x07 | 0.1 K | R/W |
| Voltage() | VOLT | 0x08 / 0x09 | mV | R |
| Flags() | FLAGS | 0x0A / 0x0B | N/A | R |
| NominalAvailableCapacity() | NAC | 0x0C / 0x0D | mAh | R |
| FullAvailableCapacity() | FAC | 0x0E / 0x0F | mAh | R |
| RemainingCapacity() | RM | 0x10 / 0x11 | mAh | R |
| FullChargeCapacity() | FCC | 0x12 / 0x13 | mAh | R |
| AverageCurrent() | Al | 0x14 / 0x15 | mA | R |
| TimeToEmpty() | TTE | 0x16 / 0x17 | Minutes | R |
| StandbyCurrent() | SI | 0x1A / 0x1B | mA | R |
| StandbyTimeToEmpty() | STTE | 0x1C / 0x1D | Minutes | R |
| AvailableEnergy() | AE | 0x22 / 0x23 | mWh/cWh | R |
| AveragePower() | AP | 0x24 / 0x25 | mW/CW | R |
| TTEatConstantPower() | TTECP | 0x26 / 0x27 | Minutes | R |
| StateOfHealth() | SOH | 0x28 / 0x29 | % / num | R |
| CycleCount() | CC | 0x2A / 0x2B | num | R |
| StateOfCharge() | SOC | 0x2C / 0x2D | % | R |
| InstantaneousCurrent Reading() | ICR | 0x30 / 0x31 | mA | R |
| InternalTemperature() | ITEMP | 0x36 / 0x37 | 0.1 K | R |
| OperationConfiguration() | OPCFG | 0x3A / 0x3B | N/A | R |



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4.1.1.1 Control(): 0x00/0x01

Issuing a Control() command requires a subsequent 2-byte subcommand. These additional bytes specify the particular control function desired. The Control() command allows the system to control specific features of the bq27520-G3 during normal operation and additional features when the device is in different access modes, as described in Table 4-2.

Table 4-2. Control() Subcommands

| CNTL FUNCTION | CNTL DATA | SEALED ACCESS | DESCRIPTION | | | |
|-----------------|--------------|------------------|---|--|--|--|
| CONTROL_STATUS | 0x0000 | Yes | Reports the status of DF checksum, hibernate, IT, etc. | | | |
| DEVICE_TYPE | 0x0001 | Yes | Reports the device type (for example: 0x0520) | | | |
| FW_VERSION | 0x0002 | Yes | Reports the firmware version on the device type | | | |
| PREV_MACWRITE | 0x0007 | Yes | Returns previous MAC subcommand code | | | |
| CHEM_ID | 0x0008 | Yes | Reports the chemical identifier of the Impedance Track™ configuration | | | |
| OCV_CMD | 0x000C | Yes | Request the gauge to take a OCV measurement | | | |
| BAT_INSERT | 0x000D | Yes | Forces the BAT_DET bit set when the [BIE] bit is 0 | | | |
| BAT_REMOVE | 0x000E | Yes | Forces the BAT_DET bit clear when the [BIE] bit is 0 | | | |
| SET_HIBERNATE | 0x0011 | Yes | Forces CONTROL_STATUS [HIBERNATE] to 1 | | | |
| CLEAR_HIBERNATE | 0x0012 | Yes | Forces CONTROL_STATUS [HIBERNATE] to 0 | | | |
| SET_SLEEP+ | 0x0013 | Yes | Forces CONTROL_STATUS [SNOOZE] to 1 | | | |
| CLEAR_SLEEP+ | 0x0014 | Yes | Forces CONTROL_STATUS [SNOOZE] to 0 | | | |
| FACTORY_RESTORE | 0x0015 | No | Forces a Factory Restore of learned resistance and Qmax to defaults | | | |
| DF_VERSION | 0x001F | Yes | Returns the Data Flash Version code | | | |
| SEALED | 0x0020 | No | Places the bq27520-G3 in SEALED access mode | | | |
| IT_ENABLE | 0x0021 | No | Enables the Impedance Track™ algorithm | | | |
| RESET | 0x0041 | No | Forces a full reset of the bq27520-G3 | | | |

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4.1.1.1.1 CONTROL STATUS: 0x0000

Instructs the fuel gauge to return status information to control addresses 0x00/0x01. The status word includes the following information.

Table 4-3. CONTROL_STATUS Bit Definitions

| | bit7 | bit6 | bit5 | bit4 | bit3 | bit2 | bit1 | bit0 |
|-----------|----------|-----------|--------|-------|------|---------|------------|---------|
| High byte | RSVD | FAS | SS | - | CCA | BCA | OCVCMDCOMP | OCVFAIL |
| Low byte | INITCOMP | HIBERNATE | SNOOZE | SLEEP | LDMD | RUP_DIS | VOK | QEN |

FAS = Status bit indicating the bq27520-G3 is in FULL ACCESS SEALED state. Active when set.

SS = Status bit indicating the bg27520-G3 is in SEALED state. Active when set.

CCA = Status bit indicating the bq27520-G3 Coulomb Counter Calibration routine is active. The CCA routine will take place approximately 1 minute after the initialization and periodically as gauging conditions change. Active when set.

BCA = Status bit indicating the bg27520-G3 board calibration routine is active. Active when set.

OCVCMDCOMP = Status bit indicating the bq27520-G3 has executed the OCV command. This bit can only be set with battery's presence. True when set.

OCVFAIL = Status bit indicating bq27520-G3 OCV reading failed due to the current. This bit can only be set with battery's presence. True when set.

INITCOMP = Initialization completion bit indicating the initialization completed. This bit can only be set with battery's presence and can be monitored to determine when gauge values are valid. True when set.

HIBERNATE = Status bit indicating a request for entry into HIBERNATE from SLEEP mode. True when set. Default is 0.

SNOOZE = Status bit indicating the bq27520-G3 SLEEP+ mode is enabled. True when set.

SLEEP = Status bit indicating the bq27520-G3 is in SLEEP mode. True when set.

LDMD = Status bit indicating the bq27520-G3 Impedance Track™ algorithm is using constant-power mode. True when set. Default is 0 (constant-current mode).

RUP_DIS = Status bit indicating the bg27520-G3 Ra table updates are disabled. Updates disabled when set.

VOK = Status bit indicating the bq27520-G3 voltages are okay for Qmax updates and calculations. True when set.

QEN = Status bit indicating the bq27520-G3 Qmax updates enabled. True when set.

4.1.1.1.2 DEVICE TYPE: 0x0001

Instructs the fuel gauge to return the device type to addresses 0x00/0x01. The bq27520-G3 device type returned is 0x0520.

4.1.1.1.3 FW VERSION: 0x0002

Instructs the fuel gauge to return the firmware version to addresses 0x00/0x01. The bq27520-G3 firmware version returned is 0x0323.

4.1.1.1.4 PREV MACWRITE: 0x0007

Instructs the fuel gauge to return the previous subcommand written to addresses 0x00/0x01. **Note:** This subcommand is only supported for previous subcommand codes 0x0000 through 0x0014. For subcommand codes greater than 0x0009, a value of 0x0007 is returned.

4.1.1.1.5 CHEM ID: 0x0008

Instructs the fuel gauge to return the chemical identifier for the Impedance Track™ configuration to addresses 0x00/0x01.

4.1.1.1.6 OCV_CMD: 0X000C

This command is to request the gauge to take an Open Circuit Voltage (OCV) reading. This command can only be issued after the [INITCOMP] has been set, indicating the initialization has been completed. The OCV measurement takes place at the beginning of the next repeated 1s firmware synchronization clock and the SOC_INT pin will pulse for approximately 165mS to indicate the measurement window. For a valid OCV reading, the host should reduce the system load current below a C/20 rate within 8ms after the leading edge of SOC_INT assertion and maintain the reduced load for the remaining 165mS window. The OCV command [OCVFAIL] bit will be set if the OCV_CMD is issued when [CHG_INH] is set.



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4.1.1.1.7 BAT INSERT: 0X000D

This command is to force the BAT_DET bit to be set when the battery insertion detection is disabled (BIE = 0). When the BIE is set to 0, the battery insertion detection is disabled. The gauge relies on the host to inform it of the battery insertion with this command to set the BAT_DET bit. Alternatively, battery insertion can be detected by the gauge by using the external thermistor network when BIE is set to 1.

4.1.1.1.8 BAT_REMOVE: 0X000E

This command is to force the BAT_DET bit to be clear when the battery insertion detection is disabled. When the BIE is set to 0, the battery insertion detection is disabled. The gauge relies on the host to inform if of the battery removal with this command to clear the BAT_DET bit.

4.1.1.1.9 SET HIBERNATE: 0x0011

Instructs the fuel gauge to force the CONTROL_STATUS [HIBERNATE] bit to 1. This will allow the gauge to enter the HIBERNATE power mode after the transition to SLEEP power state is detected and required conditions are met. The [HIBERNATE] bit is automatically cleared upon exiting from HIBERNATE mode.

4.1.1.1.10 CLEAR HIBERNATE: 0x0012

Instructs the fuel gauge to force the CONTROL_STATUS [HIBERNATE] bit to 0. This prevents the gauge from entering the HIBERNATE power mode after the transition to the SLEEP power state is detected. It can also be used to force the gauge out of HIBERNATE mode.

4.1.1.1.11 ENABLE SLEEP+ MODE: 0X0013

Instructs the fuel gauge to set the CONTROL_STATUS [SNOOZE] bit to 1. This will enable the SLEEP+ mode. The gauge will enter SLEEP+ power mode after the transition conditions are meet.

4.1.1.1.12 DISABLE SLEEP+ MODE: 0X0014

Instructs the fuel gauge to set the CONTROL_STATUS [SNOOZE] bit to 0. This will disable the SLEEP+ mode. The gauge will exit from the SLEEP+ power mode after the SNOOZE bit is cleared.

4.1.1.1.13 FACTORY RESTORE: 0X0015

Instructs the fuel gauge to reset learned resistance tables and Qmax values to the default values. If *Operation Configuration B [INDFACRES]* is set, SOC_INT is asserted while the restore is in progress. This command is only available when the fuel gauge is UNSEALED.

4.1.1.1.14 DF VERSION: 0x001F

Instructs the fuel gauge to return the 16-bit data flash revision code to addresses 0x00/0x01. The code is stored in **Data Flash Version** and provides a simple method for the customer to control data flash revisions. The default DF_VERSION is 0x0000 as configured in data flash.

4.1.1.1.15 SEALED: 0x0020

Instructs the fuel gauge to transition from the UNSEALED state to the SEALED state. The fuel gauge must always be set to the SEALED state for use in end equipment.

4.1.1.1.16 IT_ENABLE: 0x0021

This command forces the fuel gauge to begin the Impedance TrackTM algorithm, sets the *IT Enable* to 0x01 and causes the *[VOK]* and *[QEN]* flags to be set in the CONTROL_STATUS register. *[VOK]* is cleared if the voltages are not suitable for a Qmax update. This command is only available when the fuel gauge is UNSEALED and is typically enabled at the last step of production after system test is completed.

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4.1.1.1.17 RESET: 0x0041

This command instructs the fuel gauge to perform a full reset. This command is only available when the fuel gauge is UNSEALED.

4.1.1.2 AtRate(): 0x02/0x03

The AtRate() read-/write-word function is the first half of a two-function command set used to set the AtRate value used in calculations made by the AtRateTimeToEmpty() function. The AtRate() units are in mA.

The AtRate() value is a signed integer, with negative values interpreted as a discharge current value. The AtRateTimeToEmpty() function returns the predicted operating time at the AtRate value of discharge. The default value for AtRate() is zero and forces AtRateTimeToEmpty() to return 65,535. Both the AtRate() and AtRateTimeToEmpty() commands must only be used in NORMAL mode.

4.1.1.3 AtRateTimeToEmpty(): 0x04/0x05

This read-word function returns an unsigned integer value of the predicted remaining operating time if the battery is discharged at the AtRate() value in minutes with a range of 0 to 65,534. A value of 65,535 indicates AtRate() = 0. The fuel gauge updates AtRateTimeToEmpty() within 1 s after the system sets the AtRate() value. The fuel gauge automatically updates AtRateTimeToEmpty() based on the AtRate() value every 1 s. Both the AtRate() and AtRateTimeToEmpty() commands must only be used in NORMAL mode.

4.1.1.4 Temperature(): 0x06/0x07

This read-/write-word function returns an unsigned integer value of the temperature in units of 0.1 K measured by the fuel gauge. If [WRTEMP] bit = 1, a write command sets the temperature to be used for gauging calculations while a read command returns to temperature previously written. If [WRTEMP] bit = 0, a read command will return the internal temperature sensor value ([TEMPS] bit = 0) or external thermistor temperature ([TEMPS] bit = 1).

4.1.1.5 Voltage(): 0x08/0x09

This read-word function returns an unsigned integer value of the measured cell-pack voltage in mV with a range of 0 to 6000 mV.

4.1.1.6 Flags(): 0x0A/0x0B

This read-word function returns the contents of the fuel-gauge status register, depicting the current operating status.

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Table 4-4. Flags Bit Definitions

| | bit7 | bit6 | bit5 | bit4 | bit3 | bit2 | bit1 | bit0 |
|-----------|------|------|--------|---------|---------|------|---------|------|
| High byte | OTC | OTD | _ | _ | CHG_INH | XCHG | FC | CHG |
| Low byte | _ | _ | OCV_GD | WAIT_ID | BAT_DET | SOC1 | SYSDOWN | DSG |

OTC = Overtemperature in charge condition is detected. True when set. SOC_INT will toggle once if set.

OTD = Overtemperature in discharge condition is detected. True when set, SOC INT will toggle once if set.

CHG_INH = Charge inhibit: unable to begin charging (temperature outside the range [Charge Inhibit Temp Low, Charge Inhibit Temp High]). True when set.

XCHG = Charge suspend alert (temperature outside the range [Suspend Temperature Low, Suspend Temperature High]). True when set

FC = Full-charged is detected. FC is set when charge termination is reached and FC Set% = -1 (See the Charging and Charge Termination Indication section for details) or State of Charge is larger than FC Set% and FC Set% is not -1. True when set.

CHG = (Fast) charging allowed. True when set.

OCV_GD = Good OCV measurement taken. True when set.

WAIT_ID = Waiting to identify inserted battery. True when set.

BAT DET = Battery detected. True when set.

SOC1 = State-of-charge threshold 1 (SOC1 Set) reached. The flag is enabled when BL_INT bit in Operation Configuration B is set. True when set.

SysDown = SystemDown bit indicating the system should shut down. Refer to the Data Flash **SysDown** parameters for threshold settings. True when set. SOC_INT will toggle once if set.

DSG = Discharging detected. True when set.

4.1.1.7 NominalAvailableCapacity(): 0x0C/0x0D

This read-only command pair returns the uncompensated (less than C/20 load) battery capacity remaining. Units are mAh.

4.1.1.8 FullAvailableCapacity(): 0x0E/0x0F

This read-only command pair returns the uncompensated (less than C/20 load) capacity of the battery when fully charged. Units are mAh. *FullAvailableCapacity()* is updated at regular intervals, as specified by the IT algorithm.

4.1.1.9 RemainingCapacity(): 0x10/0x11

This read-only command pair returns the remaining battery capacity which is compensated for the present conditions of load, temperature and battery age. *RemainingCapacity()* is typically lower than the uncompensated *NominalAvailableCapacity()*. Units are mAh.

4.1.1.10 FullChargeCapacity(): 0x12/0x13

This read-only command pair returns the capacity of the battery when fully charged with compensation for the present conditions of temperature and battery age. *FullChargeCapacity()* is updated at regular intervals, as specified by the IT algorithm typically lower than the uncompensated *FullAvailableCapacity()*. Units are mAh.

4.1.1.11 AverageCurrent(): 0x14/0x15

This read-only command pair returns a signed integer value that is the average current flow through the sense resistor. *AverageCurrent()* is calculated by dividing the 1 second change in coulomb counter data by 1 second. Large current spikes of short duration will be averaged out in this measurement. Units are mA.

This read-only function returns an unsigned integer value of the predicted remaining battery life at the present rate of discharge, in minutes. A value of 65,535 indicates battery is not being discharged.

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4.1.1.13 StandbyCurrent(): 0x1A/0x1B

This read-only function returns a signed integer value of the measured standby current through the sense resistor. The StandbyCurrent() is an adaptive measurement. Initially it reports the standby current programmed in Initial Standby, and after spending several seconds in standby, reports the measured standby current.

The register value is updated every 1 second when the measured current is above the **Deadband** and is less than or equal to 2 x Initial Standby. The first and last values that meet this criteria are not averaged in, since they may not be stable values. To approximate a 1 minute time constant, each new StandbyCurrent() value is computed by taking approximate 93% weight of the last standby current and approximate 7% of the current measured average current.

4.1.1.14 StandbyTimeToEmpty(): 0x1C/0x1D

This read-only function returns an unsigned integer value of the predicted remaining battery life at the standby rate of discharge, in minutes. The computation uses Nominal Available Capacity (NAC), the uncompensated remaining capacity, for this computation. A value of 65,535 indicates battery is not being discharged.

This read-only function returns an unsigned integer value of the predicted charge or energy remaining in the battery. The value is reported in units of mW (Design Energy Scale = 1) or cW (Design Energy Scale = 1).

4.1.1.16 AveragePower(): 0x24/0x25

This read-only function returns an signed integer value of the average power during battery charging and discharging. It is negative during discharge and positive during charge. The value is reported in units of mW (Design Energy Scale = 1) or cW (Design Energy Scale = 10).

4.1.1.17 TimeToEmptyAtConstantPower(): 0x26/0x27

This read-only function returns an unsigned integer value of the predicted remaining operating time if the battery is discharged at the AveragePower() value in minutes. A value of 65,535 indicates AveragePower() = 0. The fuel gauge automatically updates TimeToEmptyatContantPower() based on the AveragePower() value every 1 s.

4.1.1.18 StateofHealth(): 0x28/0x29

0x28 SOH percentage: this read-only function returns an unsigned integer value, expressed as a percentage of the ratio of predicted FCC(25°C, SOH LoadI) over the DesignCapacity(). The FCC(25°C, SOH LoadI) is the calculated full charge capacity at 25°C and the SOH LoadI which is specified in the data flash. The range of the returned SOH percentage is 0x00 to 0x64, indicating 0 to 100% correspondingly.

0x29 SOH Status: this read-only function returns an unsigned integer value, indicating the status of the SOH percentage. The meanings of the returned value are:

- 0x00: SOH not valid before initialization
- 0x01: Instant SOH value ready
- 0x02: Initial SOH value ready. The calculation is based on uncompensated Qmax and is updated at first grid point during discharger after cell insertion.
- 0x03: SOH value ready. The calculation is based on updated compensated Qmax value. The updated Qmax value is measured after charge/relaxation or Fast Qmax onditions are met.
- 0x04-0xFF: Reserved

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4.1.1.19 CycleCount(): 0x2A/0x2B

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This read-only function returns an unsigned integer value of the number of cycles that the active cell has experienced with a range of 0 to 65535. One cycle occurs when accumulated discharge ≥ *CC Threshold*. The gauge maintains a separate cycle counter for both cell profiles and will reset to zero if the insertion of a new pack has been detected.

4.1.1.20 StateOfCharge(): 0x2C/0x2D

This read-only function returns an unsigned integer value of the predicted remaining battery capacity expressed as a percentage of FullChargeCapacity(), with a range of 0 to 100%.

4.1.1.21 InstantaneousCurrent Reading() 0x30/0x31

This read-only function returns a signed integer value that is the instantaneous current flow through the sense resistor. The conversion time is 125ms. It is updated every 1 second. Units are mA.

4.1.1.22 InternalTemperature(): 0x36/0x37

This read-only function returns an unsigned integer value of the internal temperature sensor in units of 0.1 K measured by the fuel gauge. This function can be useful as an additional system-level temperature monitor if the main *Temperature()* function is configured for external or host reported temperature.

4.1.1.23 OperationConfiguration(): 0x3A/0x3B

This read-only function returns the contents of the data flash *Operation Configuration* register and is most useful for system level debug to quickly determine device configuration.

4.1.2 Extended Data Commands

Extended commands offer additional functionality beyond the standard set of commands. They are used in the same manner; however, unlike standard commands, extended commands are not limited to 2-byte words. The number of commands bytes for a given extended command ranges in size from single to multiple bytes, as specified in Table 4-5.

COMMAND **SEALED UNSEALED UNITS** NAME ACCESS (1) (2) ACCESS(1) (2) CODE Reserved **RSVD** 0x34...0x3B N/A R R DesignCapacity() **DCAP** 0x3C / 0x3D mAh R R DataFlashClass()(2) **DFCLS** 0x3E N/A N/A R/W DataFlashBlock()(2) **DFBLK** 0x3F N/A R/W R/W BlockData() DFD 0x40...0x5F N/A R R/W **DFDCKS** R/W R/W BlockDataCheckSum() 0x60 N/A R/W **DFDCNTL** 0x61 N/A BlockDataControl() N/A **APPSTAT** N/A R R ApplicationStatus() 0x6A **RSVD** 0x6B...0x7F Reserved N/A R R

Table 4-5. Extended Data Commands

4.1.2.1 DesignCapacity(): 0x3C/0x3D

SEALED and UNSEALED Access: This command returns the value stored in *Design Capacity* and is expressed in mAh. This is intended to be the theoretical or nominal capacity of a new pack, but has no bearing on the operation of the fuel gauge functionality except for the calculation of *StateOfHealth()*.

¹⁾ SEALED and UNSEALED states are entered via commands to Control() 0x00/0x01.

⁽²⁾ In sealed mode, data flash CANNOT be accessed through commands 0x3E and 0x3F.

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4.1.2.2 DataFlashClass(): 0x3E

UNSEALED Access: This command sets the data flash class to be accessed. The class to be accessed must be entered in hexadecimal.

SEALED Access: This command is not available in SEALED mode.

4.1.2.3 DataFlashBlock(): 0x3F

UNSEALED Access: This command sets the data flash block to be accessed. When 0x00 is written to BlockDataControl(), DataFlashBlock() holds the block number of the data flash to be read or written. Example: writing a 0x00 to DataFlashBlock() specifies access to the first 32-byte block, a 0x01 specifies access to the second 32-byte block, and so on.

SEALED Access: This command directs which data flash block is accessed by the BlockData() command. Writing a 0x01 or 0x02 instructs the BlockData() command to transfer the Manufacturer Info Block. All other DataFlashBlock() values are reserved.

4.1.2.4 BlockData(): 0x40...0x5F

UNSEALED Access: This data block is the remainder of the 32 byte data block when accessing data flash.

SEALED Access: This data block is the remainder of the 32 byte data block when accessing Manufacturer Block Info.

4.1.2.5 BlockDataChecksum(): 0x60

UNSEALED Access: This byte contains the checksum on the 32 bytes of block data read or written to data flash. The least-significant byte of the sum of the data bytes written must be complemented ([255 – x], for x the least-significant byte) before being written to 0x60.

SEALED Access: This byte contains the checksum for the 32 bytes of block data written to the Manufacturer Info Block. The least-significant byte of the sum of the data bytes written must be complemented ([255 - x], for x the least-significant byte) before being written to 0x60.

4.1.2.6 BlockDataControl(): 0x61

UNSEALED Access: This command is used to control data flash access mode. Writing 0x00 to this command enables BlockData() to access general data flash. Writing a 0x01 to this command enables SEALED mode operation of DataFlashBlock().

SEALED Access: This command is not available in SEALED mode.

4.1.2.7 ApplicationStatus(): 0x6a

This byte function allows the system to read the bq27520-G3 Application Status data flash location. See Table 6-1 for specific bit definitions.

4.1.2.8 Reserved — 0x6B-0x7F

Data Flash Interface 4.2

4.2.1 Accessing The Data Flash

The bq27520-G3 data flash is a non-volatile memory that contains bq27520-G3 initialization, default, cell status, calibration, configuration, and user information. The data flash can be accessed in several different ways, depending on what mode the bq27520-G3 is operating in and what data is being accessed.

Commonly accessed data flash memory locations, frequently read by a system, are conveniently accessed through specific instructions, already described in Section 4.1, DATA COMMANDS. These commands are available when the bg27520-G3 is either in UNSEALED or SEALED modes.



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Most data flash locations, however, are only accessible in UNSEALED mode by use of the bq27520-G3 evaluation software or by data flash block transfers. These locations should be optimized and/or fixed during the development and manufacture processes. They become part of a golden image file and can then be written to multiple battery packs. Once established, the values generally remain unchanged during end-equipment operation.

To access data flash locations individually, the block containing the desired data flash location(s) must be transferred to the command register locations, where they can be read to the system or changed directly. This is accomplished by sending the set-up command <code>BlockDataControl()</code> (0x61) with data 0x00. Up to 32 bytes of data can be read directly from the <code>BlockData()</code> (0x40...0x5f), externally altered, then rewritten to the <code>BlockData()</code> command space. Alternatively, specific locations can be read, altered, and rewritten if their corresponding offsets are used to index into the <code>BlockData()</code> command space. Finally, the data residing in the command space is transferred to data flash, once the correct checksum for the whole block is written to <code>BlockDataChecksum()</code> (0x60).

Occasionally, a data flash CLASS will be larger than the 32-byte block size. In this case, the DataFlashBlock() command is used to designate which 32-byte block the desired locations reside in. The correct command address is then given by 0x40 + offset modulo 32. For example, to access Terminate Voltage in the Gas Gauging class, DataFlashClass() is issued 80 (0x50) to set the class. Because the offset is 53, it must reside in the second 32-byte block. Hence, DataFlashBlock() is issued 0x01 to set the block offset, and the offset used to index into the BlockData() memory area is 0x40 + 53 modulo 32 = 0x40 + 21 = 0x40 + 0x15 = 0x55.

Reading and writing subclass data are block operations up to 32 bytes in length. If during a write the data length exceeds the maximum block size, then the data is ignored.

None of the data written to memory are bounded by the bq27520-G3 – the values are not rejected by the fuel gauge. Writing an incorrect value may result in hardware failure due to firmware program interpretation of the invalid data. The written data is persistent, so a power-on reset does resolve the fault.



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4.3 Manufacturer Information Block

The bq27520-G3 contains 32 bytes of user programmable data flash storage called the *Manufacturer Info Block*. The method for accessing these memory locations is slightly different, depending on whether the device is in UNSEALED or SEALED modes.

When in UNSEALED mode and when and 0x00 has been written to <code>BlockDataControl()</code>, accessing the manufacturer information blocks is identical to accessing general data flash locations. First, a <code>DataFlashClass()</code> command is used to set the subclass, then a <code>DataFlashBlock()</code> command sets the offset for the first data flash address within the subclass. The <code>BlockData()</code> command codes contain the referenced data flash data. When writing the data flash, a checksum is expected to be received by <code>BlockDataChecksum()</code>. Only when the checksum is received and verified is the data actually written to data flash.

When in SEALED mode or when 0x01 *BlockDataControl()* does not contain 0x00, data flash is no longer available in the manner used in UNSEALED mode. Rather than issuing subclass information, a designated Manufacturer Information Block is selected with the *DataFlashBlock()* command. Issuing a 0x01 or 0x02 with this command causes the corresponding information block to be transferred to the command space 0x40...0x5f for editing or reading by the system. Upon successful writing of checksum information to *BlockDataChecksum()*, the modified block is returned to data flash. *Note: The Manufacturer Info Block* is read-only when in SEALED mode.

4.4 Access Modes

The bq27520-G3 provides three security modes (FULL ACCESS, UNSEALED, and SEALED) that control data flash access permissions, according to Table 4-6. Data Flash refers to those data flash locations, specified in Table 4-7, that are accessible to the user.

 Security Mode
 Data Flash
 Manufacture Info Block

 FULL ACCESS
 R/W
 R/W

 UNSEALED
 R/W
 R/W

Table 4-6. Data Flash Access

None

Although FULL ACCESS and UNSEALED modes appear identical, only FULL ACCESS allows the bq27520-G3 to write access-mode transition keys.

4.5 Sealing/Unsealing Data Flash

SEALED

The bq27520-G3 implements a key-access scheme to transition between SEALED, UNSEALED, and FULL-ACCESS modes. Each transition requires that a unique set of two keys be sent to the bq27520-G3 via the *Control()* control command. The keys must be sent consecutively, with no other data being written to the *Control()* register in between. Note that to avoid conflict, the keys must be different from the codes presented in the *CNTL DATA* column of Table 4-2 subcommands.

When in SEALED mode, the CONTROL_STATUS [SS] bit is set, but when the UNSEAL keys are correctly received by the bq27520-G3, the [SS] bit is cleared. When the full-access keys are correctly received, then the CONTROL_STATUS [FAS] bit is cleared.

Both the sets of keys for each level are 2 bytes each in length and are stored in data flash. The UNSEAL key (stored at *Unseal Key 0* and *Unseal Key 1*) and the FULL-ACCESS key (stored at *Full-Access Key 0* and *Full-Access Key 1*) can only be updated when in FULL-ACCESS mode. The order of the keys is *Key 1* followed by *Key 0*. The order of the bytes entered through the *Control()* command is the reverse of what is read from the part. For example, if the *Key 1* and *Key 0* of the *Unseal Keys* returns 0x1234 and 0x5678, then the *Control()* should supply 0x3412 and 0x7856 to unseal the part.

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4.6 Data Flash Summary

INSTRUMENTS

Table 4-7 summarizes the data flash locations available to the user, including their default, minimum, and maximum values.

Table 4-7. Data Flash Summary

| Class | Subclass ID | Subclass | Offset | Name | Data Type | Min Value | Max Value | Default Value | Units |
|---------------|----------------|-----------------------------|--------|------------------------------|--------------|--------------|--------------|--------------------|---------|
| Configuration | 2 | Safety | 0 | OT Chg | 12 | 0 | 1200 | 550 | 0.1°C |
| Configuration | 2 | Safety | 2 | OT Chg Time | U1 | 0 | 60 | 2 | S |
| Configuration | 2 | Safety | 3 | OT Chg Recovery | 12 | 0 | 1200 | 500 | 0.1°C |
| Configuration | 2 | Safety | 5 | OT Dsg | 12 | 0 | 1200 | 600 | 0.1°C |
| Configuration | 2 | Safety | 7 | OT Dsg Time | U1 | 0 | 60 | 2 | S |
| Configuration | 2 | Safety | 8 | OT Dsg Recovery | 12 | 0 | 1200 | 550 | 0.1°C |
| Configuration | 32 | Charge Inhibit Temp Low | 0 | Charge Inhibit Temp Low | I2 | -400 | 1200 | 0 | 0.1°C |
| Configuration | 32 | Charge Inhibit Temp High | 2 | Charge Inhibit Temp High | 12 | -400 | 1200 | 450 | 0.1°C |
| Configuration | 32 | Temp Hysteresis | 4 | Temp Hys | 12 | 0 | 100 | 50 | 0.1°C |
| Configuration | 34 | Charge | 2 | Charging Voltage | 12 | 0 | 4600 | 4200 | mV |
| Configuration | 34 | Charge | 4 | Delta Temp | 12 | 0 | 500 | 50 | 0.1°C |
| Configuration | 34 | Charge | 6 | Suspend Low Temp | 12 | -400 | 1200 | -50 | 0.1°C |
| Configuration | 34 | Charge | 8 | Suspend High Temp | 12 | -400 | 1200 | 550 | 0.1°C |
| Configuration | 36 | Charge Termination | 2 | Taper Current | 12 | 0 | 1000 | 100 | mA |
| Configuration | 36 | Charge Termination | 4 | Min Taper Capacity | 12 | 0 | 1000 | 25 | 0.01mAh |
| Configuration | 36 | Charge Termination | 6 | Taper Voltage | I2 | 0 | 1000 | 100 | mV |
| Configuration | 36 | Charge Termination | 8 | Current Taper Window | U1 | 0 | 60 | 40 | S |
| Configuration | 36 | Charge Termination | 11 | FC Set % | I1 | -1 | 100 | 100 | % |
| Configuration | 36 | Charge Termination | 12 | FC Clear % | I1 | -1 | 100 | 98 | % |
| Configuration | 36 | Charge Termination | 13 | DOD at EOC | 12 | 0 | 1000 | 100 | 0.1°C |
| Configuration | 48 | Data | 4 | Initial Standby Current | l1 | -128 | 0 | -10 | mA |
| Configuration | 48 | Data | 5 | Initial Max Load Current | 12 | -32,767 | 0 | -500 | mA |
| Configuration | 48 | Data | 7 | CC Threshold | 12 | 100 | 32,767 | 900 | mAh |
| Configuration | 48 | Data | 10 | Design Capacity | 12 | 0 | 65,535 | 1000 | mAh |
| Configuration | 48 | Data | 12 | Design Energy Scale | U1 | 1 | 10 | 1 | num |
| Configuration | 48 | Data | 13 | SOH Load | 12 | -32,767 | 0 | -400 | mA |
| Configuration | 48 | Data | 15 | Default Temp | 12 | 0 | 1000 | 250 ⁽¹⁾ | 0.1°C |
| Configuration | 48 | Data | 17 | Device name | S8 | х | х | bq27520 | - |
| Configuration | 48 | Data | 25 | Data Flash Version | H2 | 0x00 | 0xFF | 0x00 | - |
| Configuration | 49 | Discharge | 0 | SOC1 Set Threshold | U1 | 0 | 255 | 150 | mAh |
| Configuration | 49 | Discharge | 1 | SOC1 Clear Threshold | U1 | 0 | 255 | 175 | mAh |
| Configuration | 49 | Discharge | 5 | SysDown Set Volt Threshold | 12 | 0 | 4200 | 3150 | mV |
| Configuration | 49 | Discharge | 7 | SysDown Set Volt Time | U1 | 0 | 60 | 2 | s |
| Configuration | 49 | Discharge | 8 | SysDown Clear Volt Threshold | 12 | 0 | 4200 | 3400 | mV |
| Configuration | 49 | Discharge | 15 | Final Voltage | U2 | 0 | 4200 | 3000 | mV |
| Configuration | 49 | Discharge | 17 | Def Cell 0 DOD at EOC | I2 | 0 | 16384 | 0 | num |
| Configuration | 49 | Discharge | 19 | Def Cell 0 DOD at EOC | 12 | 0 | 16384 | 0 | num |

⁽¹⁾ Display as the value EVSW displayed. Data Flash value is different.



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Table 4-7. Data Flash Summary (continued)

| Table 4-7. Data i lasii Sullillal | | | | | | , | | | |
|-----------------------------------|----------------|-----------------------|--------|---------------------------------|--------------|--------------|--------------|------------------|--------------|
| Class | Subclass ID | Subclass | Offset | Name | Data Type | Min Value | Max Value | Default Value | Units |
| Configuration | 49 | Discharge | 21 | Def Avg I Last Run | 12 | -32768 | 32767 | -299 | mA |
| Configuration | 49 | Discharge | 23 | Def Avg P Last Run | I2 | -32768 | 32767 | -1133 | mW/cW |
| System Data | 57 | Manufacturer Info | 0–31 | Block [0 – 31] | H1 | 0x00 | 0xFF | 0x00 | - |
| Configuration | 64 | Registers | 0 | Operation Configuration | H2 | 0x0000 | 0xFFFF | 0x0973 | _ |
| Configuration | 64 | Registers | 7 | SOC Delta | U1 | 0 | 25 | 1 | % |
| Configuration | 64 | Registers | 8 | I ² C Timeout | U1 | 0 | 7 | 4 | num |
| Configuration | 64 | Registers | 9 | DFWrIndWaitTime | U2 | 0 | 65535 | 0 | 5µs |
| Configuration | 64 | Registers | 11 | OpConfigB | H1 | 0x00 | 0xFF | 0x4B | - |
| Configuration | 64 | Registers | 12 | OpConfigC | H1 | 0x00 | 0xFF | 0x2C | - |
| Configuration | 64 | Registers | 13 | OpConfigD | H1 | 0x00 | 0xFF | 0x3C | _ |
| Configuration | 64 | Registers | 14 | Clock Control Register | H1 | 0x00 | 0xFF | 0x09 | - |
| Configuration | 68 | Power | 0 | Flash Update OK Voltage | 12 | 0 | 4200 | 2800 | mV |
| Configuration | 68 | Power | 4 | Sleep Current | 12 | 0 | 100 | 10 | mA |
| Configuration | 68 | Power | 13 | Hibernate Current | U2 | 0 | 700 | 8 | mA |
| Configuration | 68 | Power | 15 | Hibernate Voltage | U2 | 2400 | 3000 | 2550 | mV |
| Gas Gauging | 80 | IT Cfg | 0 | Load Select | U1 | 0 | 255 | 1 | _ |
| Gas Gauging | 80 | IT Cfg | 1 | Load Mode | U1 | 0 | 255 | 0 | _ |
| Gas Gauging | 80 | IT Cfg | 21 | Max Res Factor | U1 | 0 | 255 | 20 | num |
| Gas Gauging | 80 | IT Cfg | 22 | Min Res Factor | U1 | 0 | 255 | 5 | num |
| Gas Gauging | 80 | IT Cfg | 24 | Ra Filter | U2 | 0 | 1000 | 500 | num |
| Gas Gauging | 80 | IT Cfg | 41 | Fast Qmax Start DOD% | U1 | 0 | 255 | 92 | % |
| Gas Gauging | 80 | IT Cfg | 42 | Fast Qmax End DOD% | U1 | 0 | 255 | 96 | % |
| Gas Gauging | 80 | IT Cfg | 43 | Fast Qmax Current Threshold | 12 | 0 | 1000 | 2 | Crate |
| Gas Gauging | 80 | IT Cfg | 45 | Fast Qmax Min Points | U1 | 0 | 65535 | 3 | num |
| Gas Gauging | 80 | IT Cfg | 47 | Min % Passed Charge for Qmax | U1 | 1 | 100 | 37 | % |
| Gas Gauging | 80 | IT Cfg | 51 | Qmax Filter | U1 | 0 | 255 | 96 | num |
| Gas Gauging | 80 | IT Cfg | 52 | Max Default Qmax | U1 | 0 | 255 | 110 | % |
| Gas Gauging | 80 | IT Cfg | 53 | Terminate Voltage | 12 | -32,768 | 32,767 | 3400 | mV |
| Gas Gauging | 80 | IT Cfg | 55 | Term V Delta | 12 | 0 | 4200 | 200 | mV |
| Gas Gauging | 80 | IT Cfg | 58 | ResRelax Time | U2 | 0 | 65534 | 500 | s |
| Gas Gauging | 80 | IT Cfg | 62 | User Rate-mA | 12 | -2000 | -100 | 0 | mA |
| Gas Gauging | 80 | IT Cfg | 64 | User Rate-mW/cW | 12 | -7200 | -350 | 0 | mW / cW |
| Gas Gauging | 80 | IT Cfg | 66 | Reserve Cap-mAh | 12 | 0 | 9000 | 0 | mAh |
| Gas Gauging | 80 | IT Cfg | 68 | Reserve Cap-mWh/cWh | 12 | 0 | 14,000 | 0 | mWh / cWh |
| Gas Gauging | 80 | IT Cfg | 73 | Min Delta Voltage | 12 | -32,000 | 32,000 | 0 | mV |
| Gas Gauging | 80 | IT Cfg | 75 | Max Sim Rate | U1 | 0 | 255 | 2 | C/rate |
| Gas Gauging | 80 | IT Cfg | 76 | Min Sim Rate | U1 | 0 | 255 | 20 | C/rate |
| Gas Gauging | 80 | IT Cfg | 77 | Ra MAx Delta | U2 | 0 | 65,535 | 44 | mΩ |
| Gas Gauging | 80 | IT Cfg | 79 | Qmax MAx Delta% | U1 | 0 | 255 | 5 | % |
| Gas Gauging | 80 | IT Cfg | 80 | DeltaV Max dV | U2 | 0 | 65,535 | 10 | mV |
| Gas Gauging | 80 | IT Cfg | 82 | Max Res Scale | U2 | 0 | 32767 | 5000 | num |
| Gas Gauging | 80 | IT Cfg | 84 | Min Res Scale | U2 | 0 | 32767 | 200 | num |
| Gas Gauging | 80 | IT Cfg | 86 | Fast Scale Start SOC | U1 | 0 | 100 | 10 | % |
| Gas Gauging | 81 | Current Thresholds | 0 | Dsg Current Threshold | 12 | 0 | 2000 | 60 | mA |
| Gas Gauging | 81 | Current Thresholds | 2 | Chg Current Threshold | 12 | 0 | 2000 | 75 | mA |
| | | | | | | | | | |

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Table 4-7. Data Flash Summary (continued)

| Table 4-7. Data Flash Summary (continued) | | | | | | | | | |
|---|----------------|-----------------------|--------|----------------------------|--------------|--------------|--------------|------------------|-------|
| Class | Subclass ID | Subclass | Offset | Name | Data Type | Min Value | Max Value | Default Value | Units |
| Gas Gauging | 81 | Current Thresholds | 4 | Quit Current | 12 | 0 | 1000 | 40 | mA |
| Gas Gauging | 81 | Current Thresholds | 6 | Dsg Relax Time | U2 | 0 | 8191 | 60 | s |
| Gas Gauging | 81 | Current Thresholds | 8 | Chg Relax Time | U1 | 0 | 255 | 60 | s |
| Gas Gauging | 81 | Current Thresholds | 9 | Quit Relax Time | U1 | 0 | 63 | 1 | S |
| Gas Gauging | 81 | Current Thresholds | 10 | Transient Factor Charge | U1 | 0 | 255 | 255 | num |
| Gas Gauging | 81 | Current Thresholds | 11 | Transient Factor Discharge | U1 | 0 | 255 | 255 | num |
| Gas Gauging | 81 | Current Thresholds | 12 | Max IR Correct | U2 | 0 | 1,000 | 400 | mV |
| Gas Gauging | 82 | State | 0 | IT Enable | H1 | 0x00 | 0x03 | 0x00 | _ |
| Gas Gauging | 82 | State | 1 | Application Status | H1 | 0x00 | 0xFF | 0x00 | _ |
| Gas Gauging | 82 | State | 2 | Qmax 0 | 12 | 0 | 32,767 | 1000 | mAh |
| Gas Gauging | 82 | State | 4 | Cycle Count 0 | U2 | 0 | 65,535 | 0 | _ |
| Gas Gauging | 82 | State | 6 | Update Status 0 | H1 | 0x00 | 0x03 | 0x00 | _ |
| Gas Gauging | 82 | State | 7 | Qmax 1 | 12 | 0 | 32767 | 1000 | mAh |
| Gas Gauging | 82 | State | 9 | Cycle Count 1 | U2 | 0 | 65,535 | 0 | Count |
| Gas Gauging | 82 | State | 11 | Update Status 1 | H1 | 0x00 | 0x03 | 0x00 | _ |
| Gas Gauging Gas Gauging | 82 | State | 12 | Cello Chg DOD at EoC | 12 | 0 | 16384 | 0 | _ |
| Gas Gauging Gas Gauging | 82 | State | 14 | Cell1 Chg DOD at EoC | 12 | 0 | 16384 | 0 | _ |
| | 82 | State | 16 | | 12 | -32,768 | | -299 | mA |
| Gas Gauging | 82 | | | Avg I Last Run | 12 | | 32,767 | | |
| Gas Gauging | | State | 18 | Avg P Last Run | | -32,768 | 32,767 | -1131 | mAh |
| Gas Gauging | 82 | State | 20 | Delta Voltage | 12 | -32,768 | 32,768 | 2 | mV |
| Gas Gauging | 82 | State | 24 | T Rise | U2 | 0 | 65535 | 2 | num |
| Gas Gauging | 82 | State | 26 | T Time Constant | U2 | 0 | 65535 | 1000 | num |
| OCV Table | 83 | OCVa0 Table | 0 | Chem ID 0 | H2 | 0x0 | 0xFFFF | 0x100 | num |
| OCV Table | 83 | OCVa0 Table | 2 | Qmax Cell 0 | 12 | 0 | 32767 | 1000 | mAh |
| OCV Table | 83 | OCVa0 Table | 4 | Update Status | H1 | 0x00 | 0x03 | 0x00 | - |
| OCV Table | 84 | OCVa1 Table | 0 | Chem ID 1 | H2 | 0x0 | 0xFFFF | 0x100 | num |
| OCV Table | 84 | OCVa1 Table | 2 | Qmax Cell 1 | 12 | 0 | 32767 | 1000 | mAh |
| OCV Table | 84 | OCVa1 Table | 4 | Update Status 1 | H1 | 0x00 | 0x03 | 0x00 | - |
| Default Ra | 87 | Def0 Ra | 0 | Def0 Ra Status | H1 | 0x00 | 0x00 | 0xFF | - |
| Default Ra | 87 | Def0 Ra | 1 | Def0 Ra Flag | H1 | 0x00 | 0x00 | 0x55 | - |
| Default Ra | 87 | Def0 Ra | 2-18 | Def0 Ra | H1 | 0x00 | 0xFF | - | - |
| Default Ra | 88 | Def1 Ra | 0 | Def1 Ra Status | H1 | 0x00 | 0x00 | 0xFF | _ |
| Default Ra | 88 | Def1 Ra | 1 | Def1 Ra Flag | H1 | 0x00 | 0x00 | 0x55 | - |
| Default Ra | 88 | Def1 Ra | 2-18 | Def1 Ra | H1 | 0x00 | 0xFF | - | _ |
| | | | | | | | | | |
| Ra Table | 91 | Pack0 Ra | 0 | Pack0 Ra Status | H1 | 0x00 | 0x00 | 0xFF | - |
| Ra Table | 91 | Pack0 Ra | 1 | Pack0 Ra Flag | H1 | 0x00 | 0x00 | 0x55 | - |
| Ra Table | 91 | Pack0 Ra | 2-18 | Pack0 Ra | H1 | 0x00 | 0xFF | - | - |
| Ra Table | 92 | Pack1 Ra | 0 | Pack1 Ra Status | H1 | 0x00 | 0x00 | 0xFF | - |
| Ra Table | 92 | Pack1 Ra | 1 | Pack1 Ra Flag | H1 | 0x00 | 0x00 | 0x55 | - |
| Ra Table | 92 | Pack1 Ra | 2-18 | Pack1 Ra | H1 | 0x00 | 0xFF | - | - |
| Ra Table | 93 | Pack0 Rax | 0 | Pack0 Rax Status | H1 | 0x00 | 0x00 | 0xFF | _ |
| Ra Table | 93 | Pack0 Rax | 1 | Pack0 Rax Flag | H1 | 0x00 | 0x00 | 0x55 | _ |
| | | <u> </u> | | | | | | | - |
| Ra Table | 93 | Pack0 Rax | 2-18 | Pack0 Rax | H1 | 0x00 | 0xFF | - | - |



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Table 4-7. Data Flash Summary (continued)

| Class | Subclass ID | Subclass | Offset | Name | Data Type | Min Value | Max Value | Default Value | Units |
|-------------|----------------|-----------|--------|--------------------|-------------------|--------------|--------------|----------------------|-------|
| Ra Table | 94 | Pack1 Rax | 0 | Pack1 Rax Status | H1 | 0x00 | 0x00 | 0xFF | - |
| Ra Table | 94 | Pack1 Rax | 1 | Pack1 Rax Flag | H1 | 0x00 | 0x00 | 0x55 | - |
| Ra Table | 94 | Pack1 Rax | 2-18 | Pack1 Rax | H1 | 0x00 | 0xFF | - | - |
| Calibration | 104 | Data | 0 | CC Gain | F4 ⁽²⁾ | 0.1 | 47 | 10 ⁽³⁾ | mΩ |
| Calibration | 104 | Data | 4 | CC Delta | F4 ⁽²⁾ | 4.7 | 188 | 10 ⁽³⁾ | mΩ |
| Calibration | 104 | Data | 8 | CC Offset | 12 | -2.4 | 2.4 | -0.58 ⁽³⁾ | mV |
| Calibration | 104 | Data | 12 | Board Offset | I1 | -128 | 127 | 0 | mV |
| Calibration | 104 | Data | 13 | Int Temp Offset | I1 | -128 | 127 | 0 | 0.1°C |
| Calibration | 104 | Data | 14 | Ext Temp Offset | I1 | -128 | 127 | 0 | 0.1°C |
| Calibration | 104 | Data | 15 | Pack V Offset | I1 | -128 | 127 | 0 | mV |
| Temp Model | 106 | Data | 0 | Ext a Coef 1 | 12 | -32768 | 32767 | -11130 | num |
| Temp Model | 106 | Data | 2 | Ext a Coef 2 | 12 | -32768 | 32767 | 19142 | num |
| Temp Model | 106 | Data | 4 | Ext a Coef 3 | 12 | -32768 | 32767 | -19262 | num |
| Temp Model | 106 | Data | 6 | Ext a Coef 4 | 12 | -32768 | 32767 | 28203 | num |
| Temp Model | 106 | Data | 8 | Ext a Coef 5 | 12 | -32768 | 32767 | 892 | num |
| Temp Model | 106 | Data | 10 | Ext b Coef 1 | 12 | -32768 | 32767 | 328 | num |
| Temp Model | 106 | Data | 12 | Ext b Coef 2 | 12 | -32768 | 32767 | -605 | num |
| Temp Model | 106 | Data | 14 | Ext b Coef 3 | 12 | -32768 | 32767 | -2443 | num |
| Temp Model | 106 | Data | 16 | Ext b Coef 4 | 12 | -32768 | 32767 | 4696 | num |
| Calibration | 107 | Current | 1 | Deadband | U1 | 0 | 255 | 5 | mA |
| Security | 112 | Codes | 0 | Unseal Key 0 | H2 | 0x0000 | 0xFFFF | 0x3672 | - |
| Security | 112 | Codes | 2 | Unseal Key 1 | H2 | 0x0000 | 0xFFFF | 0x0414 | - |
| Security | 112 | Codes | 4 | Unsealed to Full 0 | H2 | 0x0000 | 0xFFFF | 0xFFFF | - |
| Security | 112 | Codes | 6 | Unsealed to Full 1 | H2 | 0x0000 | 0xFFFF | 0xFFFF | - |
| Security | 112 | Codes | 8 | FactRestorkey 0 | H2 | 0x0000 | 0xFFFF | 0x0DEF | - |
| Security | 112 | Codes | 10 | FactRestorkey 1 | H2 | 0x0000 | 0xFFFF | 0x0FAC | - |

Not IEEE floating point.

FUNCTIONAL DESCRIPTION

5.1 **Fuel Gauging**

The bq27520-G3 measures the cell voltage, temperature, and current to determine battery SOC based on Impedance Track™ algorithm (Please refer to Application Report SLUA450 "Theory and Implementation of Impedance Track Battery Fuel-Gauging Algorithm" for more information). The bq27520-G3 monitors and discharge activity by sensing the voltage across a small-value (5 m Ω to 20 m Ω typ.) between the SRP and SRN pins and in series with the cell. By integrating charge passing through the battery, the battery's SOC is adjusted during battery charge or discharge.

The total battery capacity is found by comparing states of charge before and after applying the load with the amount of charge passed. When an application load is applied, the impedance of the cell is measured by comparing the OCV obtained from a predefined function for present SOC with the measured voltage under load. Measurements of OCV and charge integration determine chemical state of charge and chemical capacity (Qmax). The initial Qmax values are taken from a cell manufacturers' data sheet multiplied by the number of parallel cells. It is also used for the value in **Design Capacity**. The bq27520-G3 acquires and updates the battery-impedance profile during normal battery usage. It uses this profile,

Display as the value EVSW displayed. Data Flash value is different.

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along with SOC and the Qmax value, to determine FullChargeCapacity() and StateOfCharge(), specifically for the present load and temperature. FullChargeCapacity() is reported as capacity available from a fully charged battery under the present load and temperature until Voltage() reaches the Terminate Voltage. NominalAvailableCapacity() and FullAvailableCapacity() are the uncompensated (no or light load) versions of RemainingCapacity() and FullChargeCapacity() respectively.

The bq27520-G3 has two flags accessed by the *Flags()* function that warns when the battery's SOC has fallen to critical levels. When *RemainingCapacity()* falls below the first capacity threshold, specified in SO*C1 Set Threshold*, the *[SOC1]* (*State of Charge Initial)* flag is set. The flag is cleared once *RemainingCapacity()* rises above SOC1 Set Threshold. The bq27520-G3's BAT_LOW pin automatically reflects the status of the *[SOC1]* flag. This flag is enabled when BL_INT bit in *Operation Configuration B* is set. All units are in mAh.

When *Voltage()* falls below the system shut down threshold voltage, *SysDown Set Volt Threshold*, the *[SYSDOWN]* flag is set, serving as a final warning to shut down the system. The SOC_INT also signals. When *Voltage()* rises above *SysDown Clear Voltage* and the *[SYSDOWN]* flag has already been set, the *[SYSDOWN]* flag is cleared. The SOC_INT also signals such change. All units are in mV.

When the voltage is discharged to *Final Voltage*, the *SOC will be set as 0*.

5.2 Impedance Track™ Variables

The bq27520-G3 has several data flash variables that permit the user to customize the Impedance $Track^{TM}$ algorithm for optimized performance. These variables are dependent upon the power characteristics of the application as well as the cell itself.

5.2.1 Load Mode

Load Mode is used to select either the constant-current or constant-power model for the Impedance $Track^{TM}$ algorithm as used in **Load Select** (see **Load Select**). When **Load Mode** is 0, the **Constant Current Model** is used (default). When 1, the **Constant Power Model** is used. The [LDMD] bit of CONTROL_STATUS reflects the status of **Load Mode**.

5.2.2 Load Select

Load Select defines the type of power or current model to be used to compute load-compensated capacity in the Impedance TrackTM algorithm. If **Load Mode** = 0 (*Constant-Current*) then the options presented in Table 5-1 are available.

Table 5-1. Constant-Current Model Used When Load Mode = 0

| LoadSelect Value | Current Model Used |
|------------------|---|
| 0 | Average discharge current from previous cycle: There is an internal register that records the average discharge current through each entire discharge cycle. The previous average is stored in this register. |
| 1(default) | Present average discharge current: This is the average discharge current from the beginning of this discharge cycle until present time. |
| 2 | Average current: based on AverageCurrent() |
| 3 | Current: based off of a low-pass-filtered version of AverageCurrent() ($\tau = 14 \text{ s}$) |
| 4 | Design capacity / 5: C Rate based off of Design Capacity /5 or a C/5 rate in mA. |
| 5 | AtRate (mA): Use whatever current is in AtRate() |
| 6 | User_Rate-mA: Use the value in <i>User_Rate-mA</i> . This mode provides a completely user-configurable method. |

If **Load Mode** = 1 (Constant Power) then the following options shown in Table 5-2 are available



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Table 5-2. Constant-Power Model Used When Load Mode = 1

| LoadSelect Value | Power Model Used |
|------------------|---|
| 0 | Average discharge power from previous cycle: There is an internal register that records the average discharge power through each entire discharge cycle. The previous average is stored in this register. |
| 1(default) | Present average discharge power: This is the average discharge power from the beginning of this discharge cycle until present time. |
| 2 | Average current x voltage: based off the AverageCurrent() and Voltage(). |
| 3 | Current x voltage: based off of a low-pass-filtered version of AverageCurrent() ($\tau = 14 \text{ s}$) and Voltage() |
| 4 | Design energy / 5: C Rate based off of Design Energy /5 or a C/5 rate in mA. |
| 5 | AtRate (10 mW): Use whatever value is in AtRate(). |
| 6 | User_Rate-10mW: Use the value in <i>User_Rate-10mW</i> . This mode provides a completely user-configurable method. |

5.2.3 Reserve Cap-mAh

Reserve Cap-mAh determines how much actual remaining capacity exists after reaching 0 RemainingCapacity(), before Terminate Voltage is reached. A no-load rate of compensation is applied to this reserve.

5.2.4 Reserve Cap-mWh/mCh

Reserve Cap-mWh/cWh determines how much actual remaining capacity exists after reaching 0 AvailableEnergy(), before Terminate Voltage is reached. A no-load rate of compensation is applied to this reserve capacity.

5.2.5 Design Energy Scale

Design Energy Scale is used to select the scale/unit of a set of data flash parameters. The value of Design Energy Scale can be either 1 or 10 only.

Table 5-3. Data Flash Parameter Scale/Unit Based on Design Energy Scale

| Data Flash | Design Energy Scale = 1 (default) | Design Energy Scale = 10 | |
|----------------------------|-----------------------------------|--------------------------|--|
| Design Energy | mWh | cWh | |
| Reservce Capacity -mWh/cWh | mWh | cWh | |
| Avg Power Last Run | mW | cW | |
| User Rate-mW/cW | mWh | cWh | |
| T Rise | No Scale | Scaled by x10 | |

5.2.6 Dsg Current Threshold

This register is used as a threshold by many functions in the bg27520-G3 to determine if significant discharge current is flowing into or out of the cell. The default for this register is in Table 4-7, which should be sufficient for most applications. This threshold should be set low enough to be below any normal application load current but high enough to prevent noise or drift from affecting the measurement.

5.2.7 Chg Current Threshold

This register is used as a threshold by many functions in the bq27520-G3 to determine if significant charge current is flowing into or out of the cell. The default for this register is in Table 4-7, which should be sufficient for most applications. This threshold should be set low enough to be below any normal charge current but high enough to prevent noise or drift from affecting the measurement.

5.2.8 Quit Current, DSG Relax Time, CHG Relax Time, and Quit Relax Time

The **Quit Current** is used as part of the Impedance Track™ algorithm to determine when the bq27520-G3 enters relaxation mode from a current-flowing mode in either the charge direction or the discharge direction. The value of Quit Current is set to a default value in Table 4-7 and should be above the standby current of the system.



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Either of the following criteria must be met to enter relaxation mode:

- | AverageCurrent() | < | Quit Current | for Dsg Relax Time
- | AverageCurrent() | < | Quit Current | for Chg Relax Time

After about 5 minutes in relaxation mode, the bq27520-G3 attempts to take accurate OCV readings. An additional requirement of dV/dt < 1 µV/s is required for the bg27520-G3 to perform Qmax updates. These updates are used in the Impedance Track™ algorithms. It is critical that the battery voltage be relaxed during OCV readings to and that the current is not be higher than C/20 when attempting to go into relaxation mode.

Quit Relax Time specifies the minimum time required for AverageCurrent() to remain above the Dsg or **Chg Current Threshold** before exiting relaxation mode.

5.2.9 Qmax 0 and Qmax 1

Generically called Qmax, these dynamic variables contain the respective maximum chemical capacity of the active cell profiles, and are determined by comparing states of charge before and after applying the load with the amount of charge passed. They also correspond to capacity at a low rate of discharge, such as the C/20 rate. For high accuracy, this value is periodically updated by the bg27520-G3 during operation. Based on the battery cell capacity information, the initial value of chemical capacity should be entered in the *Qmax* n field for each default cell profile. The Impedance Track™ algorithm updates these values and maintains them in the associated cell profiles.

5.2.10 Update Status 0 and Update Status 1

Bit 0 (0x01) of the **Update Status** n registers is updated as needed by the bg27520-G3 to indicate that new Qmax parameters have been learned. The *Update Status* n registers are modified automatically by the bq27520-G3 and Tl's evaluation software during the process of creating a golden Data Flash file. The remaining bits are reserved.

5.2.11 Avg I Last Run

The bq27520-G3 logs the current averaged from the beginning to the end of each discharge cycle. It stores this average current from the previous discharge cycle in this register. This register should not be modified. It is only updated by the bg27520-G3 when required.

5.2.12 Avg P Last Run

The bq27520-G3 logs the power averaged from the beginning to the end of each discharge cycle. It stores this average power from the previous discharge cycle in this register. To get a correct average power reading the bg27520-G3 continuously multiplies instantaneous current times Voltage() to get power. It then logs this data to derive the average power. This register should not be modified. It is only updated by the bq27520-G3 when required.

5.2.13 Delta Voltage

The bq27520-G3 stores the maximum difference of Voltage() during short load spikes and normal load, so the Impedance Track™ algorithm can calculate remaining capacity for pulsed loads. It is not recommended to change this value.

5.2.14 Default Ra and Ra Tables

These tables contain encoded data and, with the exception of the **Default Ra Tables**, are automatically updated during device operation. No user changes should be made except for reading/writing the values from a pre-learned pack (part of the process for creating golden image files).

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5.2.15 Fast Resistance Scaling

This new algorithm improves convergency of Remaing Capacity and terminate voltage at end of discharge. The algorithm is enabled when cell voltage goes below (Terminate Voltage + Term V Delta) or StateofCharge() goes below Fast Scale Start SOC. For most applications, the default value of Term V Delta and Fast Scale Start SOC are recommended.

5.2.16 Fast Qmax Update

This new algorithm improvement provides a fast Qmax update feature that can compute Qmax based on Full charge and end of discharge conditions without battery relaxation. The feature can be enabled by setting the [FASTQMAX] bit in Operation Configuration D. Several data flash parameters (Fast Qmax Start DOD%, Fast Qmax End DOD%, and Term V Delta) are used to configure the algorithm and default settings are recommended. Please note that Fast Qmax Update algorithm is not used during learning cycle.

5.3 **Detailed Pin Description**

5.3.1 The Operation Configuration Register

Some bg27520-G3 pins are configured via the **Operation Configuration** data flash register, as indicated in Table 5-4. This register is programmed/read via the methods described in Section 4.2.1, Accessing the Data Flash. The register is located at subclass = 64, offset = 0.

Table 5-4. Operation Configuration Bit Definition

| | bit7 | bit6 | bit5 | bit4 | bit3 | bit2 | bit1 | bit0 |
|-----------|----------|----------|----------|----------|----------|----------|----------|-------|
| High byte | RESCAP | BATG_OVR | INT_BREM | PFC_CFG1 | PFC_CFG0 | IWAKE | RSNS1 | RSNS0 |
| Low byte | INT_FOCV | IDSELEN | SLEEP | RMFCC | SOCI_POL | BATG_POL | BATL_POL | TEMPS |

RESCAP = No-load rate of compensation is applied to the reserve capacity calculation. True when set. Default is 0.

BATG OVR = BAT GD override bit. If the gauge enters Hibernate only due to the cell voltage, the BAT GD pin will not negate. True when set. Default is 0.

INT_BERM = Battery removal interrupt bit. The SOC_INT pulses 1ms when the battery removal interrupt is enabled. True when set. The default is 0.

PFC_CFG1/PFC_CFG0 = Pin function code (PFC) mode selection: PFC 0, 1, or 2 selected by 0/0, 0/1, or 1/0, respectively. Default is PFC 1 (0/1).

IWAKE/RSNS1/RSNS0 = These bits configure the current wake function (see Table 5-9). Default is 0/0/1.

INT_FOCV = Indication of the measurement of the OCV during the initialization. The SOC_INT will pulse during the first measurement if this bit is set. True when set. Default is 0.

IDSELEN = Enables cell profile selection feature. True when set. Default is 1.

SLEEP = The fuel gauge can enter sleep, if operating conditions allow. True when set. Default is 1.

RMFCC = RM is updated with the value from FCC, on valid charge termination. True when set. Default is 1.

SOCI_POL = SOC interrupt polarity is active-low. True when cleared. Default is 0.

 $BATG_POL = \overline{BAT_GD}$ pin is active-low. True when cleared. Default is 0.

BATL_POL = BAT_LOW pin is active-high. True when set. Default is 1.

TEMPS = Selects external thermistor for Temperature() measurements. True when set. Default is 1.

Some bq27520-G3 pins are configured via the Operation Configuration B data flash register, as indicated in Table 5-5. This register is programmed/read via the methods described in Section 4.2.1, Accessing the Data Flash. The register is located at subclass = 64, offset = 11.

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Table 5-5. Operation Configuration B Bit Definition

| bit7 | bit6 | bit5 | bit4 | bit3 | bit2 | bit1 | bit0 |
|--------|------|--------|--------|------|-----------|-----------|-----------|
| WRTEMP | BIE | BL_INT | GNDSEL | FCE | DFWrIndBL | RFACTSTEP | INDFACRES |

WRTEMP = Enables the temperature write. The temperature is expected to be written by the host and is used for gauging. Neither the external thermistor of internal temperature sensor is used. True when set. Default is 0.

BIE = Battery insertion detection enable. When the battery insertion detection is disabled, the gauge relies on the host command to set/clear the BAT_DET bit. True when set. Default is 1.

BL_INT = Battery low interrupt enable. True when set. Default is 0.

GNDSEL = The ADC ground select control. The Vss (Pin D1) is selected as ground reference when the bit is clear. Pin A1 is selected when the bit is set. Default is 0.

FCE = Fast Convergence Enable. Configures algorithm to use fast convergence method. Default is 1 and is the recommended setting for all applications.

DFWrIndBL = DataFlash Write Indication. SOC_INT is used for indication if the bit is clear. BAT_LOW is used for indication if the bit is set. Default is 0

RFACTSTEP = Enables Ra Step up/down to Min/Max Res Factor before disabling Ra updates. Default is 1.

INDFACRES = Enables SOC_INT pin to assert during FACTORY_RESTORE subcommand execution . Default is 1.

Table 5-6. Operation Configuration C Bit Definition

| bit7 | bit6 | bit5 | bit4 | bit3 | bit2 | bit1 | bit0 |
|-----------|-----------|-----------|-----------|------|----------|------------|------------|
| BATGSPUEN | BATGWPUEN | BATLSPUEN | BATLWPUEN | RSVD | SlpWkChg | DeltaVOpt1 | DeltaVOpt0 |

 $BATGSPUEN = \overline{BAT_GD} pin strong pull-up enable. Default is 0. BATGWPUEN = \overline{BAT_GD} pin weak pull-up enable. Default is 0.$

BATLSPUEN = BAT_LOW pin strong pull-up enable. Default is 1.

BATLWPUEN = BAT_LOW pin weak pull-up enable. Default is 0.

SlpWkChg = Enables compensation for the passed charge missed when waking from SLEEP mode. Default is 1.

Delta VOpt[1:0] = Configures options for determination of **Delta Voltage** which is defined as the maximum difference in Voltage() during normal load and short load spikes. Delta Voltage is a used as a compensation factor for calculating for RemainingCapacity() under pulsed loads. Default is 0/0.

0/0 = Standard DeltaV. Average variance from steady state voltage used to determine end of discharge voltage. (Default)

0/1 = No Averaging. The last instantaneous change in Voltage() from steady state is used to determine the end of discharge voltage.

1/0 = Use the value in *Min Delta Voltage*.

1/1 = Not used.

Table 5-7. Operation Configuration D Bit Definition

| bit7 | bit6 | bit5 | bit4 | bit3 | bit2 | bit1 | bit0 |
|------|------|-----------|---------|---------|--------|------|----------|
| RSVD | RSVD | SOC_STATE | SOC_OCV | SOC_DFW | SOC_OT | RSVD | FASTQMAX |

SOC STATE = Enable SOC INT pin function to generate a pulse due to battery state change. Default is 1.

SOC_OCV = Enable SOC_INT pin function to generate a pulse due to OCV command. Default is 1.

SOC_DFW = Enable SOC_INT pin function to generate a pulse due to data flash write. Default is 1.

SOC_OT = Enable SOC_INT pin function to generate a pulse due to over temperature conditions. Default is 1.

FASTQMAX = Enables Fast Qmax Update mode. True when set. Default is 0.

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5.3.2 Pin Function Code Descriptions

The bg27520-G3 has three possible pin-function variations that can be selected in accordance with the circuit architecture of the end application. Each variation has been assigned a pin function code, or PFC.

When the PFC is set to 0, only the bq27520-G3 measures battery temperature under discharge and relaxation conditions. The charger does not receive any information from the bg27520-G3 about the temperature readings, and therefore operates open-loop with respect to battery temperature.

A PFC of 1 is like a PFC of 0, except temperature is also monitored during battery charging. If charging temperature falls outside of the preset range defined in data flash, a charger can be disabled via the BAT_GD pin until cell temperature recovers. See Section 5.6.2, Charge Inhibit and Suspend, for additional details.

Finally when the PFC is set to 2, the battery thermistor can be shared between the fuel gauge and the charger. The charger has full usage of the thermistor during battery charging, while the fuel gauge uses the thermistor exclusively during discharge and battery relaxation.

When PFC = 0 or 2, the bq27520-G3 must be queried by the system in order to determine the battery temperature. At that time, the bg27520-G3 samples the temperature. This saves battery energy when operating from battery, as periodic temperature updates are avoided during charging mode. Note: Due to thermistor sharing limitations, temperature data is not available during battery charging with PFC = 2.

The PFC is specified in *Operation Configuration [PFC_CFG1, PFC_CFG0]*. The default is PFC = 1.

5.3.3 BAT LOW Pin

The BAT_LOW pin provides a system processor with an electrical indicator of battery status. The signaling on the BAT_LOW pin follows the status of the [SOC1] bit in the Flags() register. Note that the polarity of the BAT_LOW pin can be inverted via the [BATL_POL] bit of Operation Configuration.

5.3.4 Power Path Control With the BAT GD Pin

The bq27520-G3 must operate in conjunction with other electronics in a system appliance, such as chargers or other ICs and application circuits that draw appreciable power. After a battery is inserted into the system, it is preferable that no charging current or a discharging current higher than C/20 is presence, so that an accurate OCV can be read. The OCV is used for helping determine which battery profile to use, as it constitutes part of the battery impedance measurement and to determine initial SOC. To disable these functions, the BAT GD pin can be used to the charger to disable the charging function. Once an OCV reading has be made, the BAT GD pin is asserted, thereby enabling battery charging and regular discharge of the battery. The **Operation Configuration [BATG POL]** bit can be used to set the polarity of the battery good signal, should the default configuration need to be changed.

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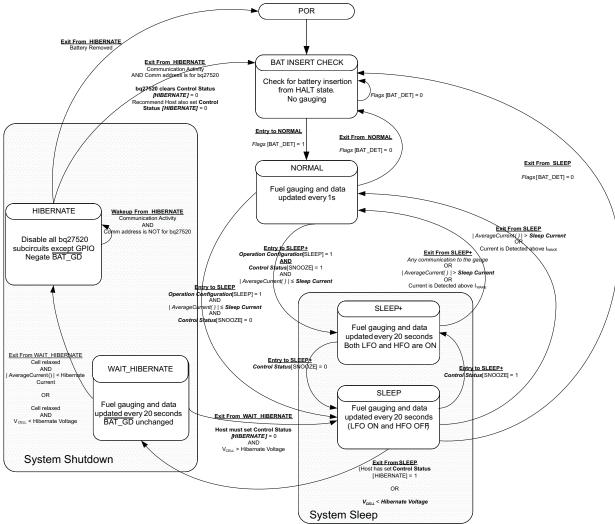


Figure 5-1. Power Mode Diagram

Figure 5-1 details how the BAT_GD pin functions in the context of battery insertion and removal, as well as NORMAL vs. SLEEP modes.

In PFC 1, the BAT GD pin is also used to disable battery charging when the bg27520-G3 reads battery temperatures outside the range defined by [Charge Inhibit Temp Low, Charge Inhibit Temp High]. The BAT GD line is asserted once temperature falls within the range [Charge Inhibit Temp Low + Temp Hys, Charge Inhibit Temp High - Temp Hys].

5.3.5 Battery Detection Using the BI/TOUT Pin

During power-up or hibernate activities, or any other activity where the bq27520-G3 needs to determine whether a battery is connected or not, the fuel gauge applies a test for battery presence when [BIE] bit is set. First, the BI/TOUT pin is put into high-Z status. The weak 1.8MΩ pull-up resistor will keep the pin high while no battery is present. When a battery is inserted (or is already inserted) into the system device, the BI/TOUT pin will be pulled low. This state is detected by the fuel gauge, which polls this pin every second when the gauge has power. A battery-disconnected status is assumed when the bg27520-G3 reads a thermistor voltage that is near 2.5V.

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When a thermistor is not used by the system for the gauge to detect battery insertion there are two options. First, the BI/TOUT pin can be tied to VSS with a resistor so the gauge will always consider a battery to be present if it has power. Second, the [BIE] bit can be cleared and the host can use the BAT INSERT and BAT REMOVE commands to inform the gauge of the battery status.

5.3.6 SOC INT pin

The SOC_INT pin generates a pulse of different pulse widths under various conditions as indicated by the table below. After initialization only one SOC_INT pulse will be generated within any given one second time slot and therefore, may indicate multiple event conditions.

Table 5-8. SOC_INT Pulse Condition and Width

| | PULSE CONDITION | ENABLE CONDITION | PULSE WIDTH | COMMENT | | |
|---------------------|--|---|---|--|--|--|
| SOC_Delt a Point | Change of StateOfCharge() | SOC_Delta ≠ 0 | 1 ms | During charge, when the SOC is greater than (>) the points, 100% – n × SOC_Delta and 100%; During discharge, when the SOC reaches (≤) the points 100% – n × SOC_Delta and 0%; where n is an integer starting from 0 to the number generating SOC no less than 0% | | |
| SOC1 Set | [SOC1] is set | [BL_INT] =1 in Operation | 1 ms | When RSOC reached the SOC1 Set or Clear | | |
| SOC1 Clear | | Configuration B | | threshold set in the Data Flash. | | |
| SysDown Set | [SYSDOWN] is set | Always | | When the Battery Voltage reached the | | |
| SysDown Clear | | | 1 ms | SysDown Set or Clear threshold set in the Data Flash | | |
| State Change | Battery State Change | SOC_Delta ≠ 0 and [SOC_STATE] bit is set in Operation Configuration D | 1 ms | When there is a state change including charging, discharging and relaxation. This function is disabled when SOC_Delta is set to 0. | | |
| Battery Removal | [INT_BREM] bit is set in OpConfig | [BIE] bit is set | 1 ms | This function is disabled when BIE is cleared. | | |
| OCV Command | After Initialization | [SOC_OCV] bit is set | About 165 ms. Same as the OCV command execution time period | SOC_INT pulses for the OCV command after the initialization. | | |
| OCV Command | [INT_FOCV] bit is set in OpConfig | Configuration D | About 165 ms. Same as the OCV command execution time period | This command is to generate the SOC_INT pulse during the initialization. | | |
| Data Flash Write | After Initialization AND DFWrIndWaitTime ≠ 0 | [SOC_DFW] bit is set in Operation Configuration D | Programmable pulse width flash (see comment) | SOC_INT is used to indicate the data flash update. The gauge will wait <i>DFWrIndWaitTime</i> times 5µs after the SOC_INT signal to start the data flash update. This function is disabled if DFWrIndWaitTime is set to 0. | | |
| OTC or OTD Flags | [OTC] or [OTD] in Flags() | [SOC_OT] bit is set in Operation Configuration D | 1 ms | Upon first assertion of Flags[<i>OTC</i>] or Flags[<i>OTD</i>] over temperature conditions. | | |
| Factory Restore | When FACTORY_RESTORE command is set | [INDFACRES] bit is set in Operation Configuration B | About 450 ms | The Factory Restore command instructs the fuel gauge to reset learned resistance tables and Qmax values to the default values. | | |



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5.4 Temperature Measurement

The bq27520-G3 measures battery temperature via its TS input, in order to supply battery temperature status information to the fuel gauging algorithm and charger-control sections of the gauge. Alternatively, it can also measure internal temperature via its on-chip temperature sensor, but only if the *[TEMPS]* bit of the *Operation Configuration* register is cleared. The *[GNDSEL]* bit of Operation Configuration B register selects the ground reference of the ADC converter for temperature measurement. A third option is enabled if the *[WRTEMP]* bit of Operation Configuration B is set. This allows a host processor to write the temperature measurement directly to the bq27520-G3 instead of the gauge making its own temperature measurements.

Regardless of which sensor is used for measurement, a system processor can request the current battery temperature by calling the *Temperature()* function (see Section 4.1.1, *Standard Data Commands*, for specific information).

The thermistor circuit requires the use of an external NTC 103AT-type thermistor. Additional circuit information for connecting this thermistor to the bq27520-G3 is shown in Section 8, Reference Schematic.

5.5 Overtemperature Indication

5.5.1 Overtemperature: Charge

If during charging, *Temperature()* reaches the threshold of **OT Chg** for a period of **OT Chg Time** and *AverageCurrent()* > **Chg Current Threshold**, then the [OTC] bit of Flags() is set. When Temperature() falls to **OT Chg Recovery**, the [OTC] of Flags() is reset.

If **OT Chg Time** = 0, then the feature is completely disabled.

5.5.2 Overtemperature: Discharge

If during discharging, Temperature() reaches the threshold of OT Dsg for a period of OT Dsg Time, and $AverageCurrent() \le -Dsg$ Current Threshold, then the [OTD] bit of Flags() is set. When Temperature() falls to OT Dsg Recovery, the [OTD] bit of Flags() is reset.

If **OT Dsg Time** = 0, then feature is completely disabled.

5.6 Charging and Charge-Termination Indication

5.6.1 Detecting Charge Termination

For proper bq27520-G3 operation, the cell charging voltage must be specified by the user. The default value for this variable is *Charging Voltage* Table 4-7.

The bq27520-G3 detects charge termination when (1) during 2 consecutive periods of *Current Taper Window*, the AverageCurrent() is < *Taper Current*, (2) during the same periods, the accumulated change in capacity > *Min Taper Capacity* / *Current Taper Window*, and (3) *Voltage*() > *Charging Voltage* - *Taper Voltage*. When this occurs, the [CHG] bit of Flags() is cleared. Also, if the [RMFCC] bit of *Operation Configuration* is set, then *RemainingCapacity*() is set equal to *FullChargeCapacity*().

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5.6.2 Charge Inhibit and Suspend

The bq27520-G3 can indicate when battery temperature has fallen below or risen above predefined thresholds *Charge Inhibit Temp Low* or *Charge Inhibit Temp High*, respectively. In this mode, the [CHG_INT] bit is set and the BAT_GD pin is deserted to indicate this condition. The [CHG_INT] bit is cleared and the BAT_GD pin is asserted once the battery temperature returns to the range *[Charge Inhibit Temp Low + Temp Hys, Charge Inhibit Temp High - Temp Hys]*.

When PFC = 1, the bq27520-G3 can indicate when battery temperature has fallen below or risen above predefined thresholds **Suspend Low Temp** or **Suspend High Temp**, respectively. In this mode, the [XCHG] bit is set to indicate this condition. The [XCHG] bit is cleared once the battery temperature returns to the range **[Charge Inhibit Temp Low + Temp Hys, Charge Inhibit Temp High - Temp Hys]**.

The charging should not start when the temperature is below the Charge Inhibit Temp Low or above the Charge Inhibit Temp High. The charging can continue if the charging starts inside the window [Charge Inhibit Temp Low, Charge Inhibit Temp High] until the temperature is either below Suspend Low Temp or above the Suspend Low Temp. Therefore, the window [Charge Inhibit Temp Low, Charge Inhibit Temp High] must be inside the window of [Suspend Low Temp, Suspend High Temp].

5.7 Power Modes

The bq27520-G3 has different power modes: BAT INSERT CHECK, NORMAL, SLEEP+, SLEEP and HIBERNATE. In NORMAL mode, the bq27520-G3 is fully powered and can execute any allowable task. In SLEEP+ mode, both low frequency and high frequency oscillators are active. Although the SLEEP+ has higher current consumption than the SLEEP mode, it is also a reduced power mode. In SLEEP mode, the fuel gauge turns off the high frequency oscillator and exists in a reduced-power state, periodically taking measurements and performing calculations. In HIBERNATE mode, the fuel gauge is in a low power state, but can be woken up by communication or certain I/O activity. Finally, the BAT INSERT CHECK mode is a powered-up, but low-power halted, state, where the bq27520-G3 resides when no battery is inserted into the system.

The relationship between these modes is shown in Figure 5-1.

5.7.1 BAT INSERT CHECK Mode

This mode is a halted-CPU state that occurs when an adapter, or other power source, is present to power the bq27520-G3 (and system), yet no battery has been detected. Depending on the setting of the *[BIE]* bit in the Operation Configuration B dataflash register, the bq27520-G3 will detect battery insertion either through use of the thermistor network and BI/TOUT pin, or the host can use the BAT_INSERT and BAT_REMOVE commands to inform the battery presence status. When battery insertion is detected, a series of initialization activities begin, which include: OCV measurement, setting the BAT_GD pin, and selecting the appropriate battery profiles.

Some commands, issued by a system processor, can be processed while the bq27520-G3 is halted in this mode. The gauge will wake up to process the command, then return to the halted state awaiting battery insertion.

5.7.2 NORMAL Mode

The fuel gauge is in NORMAL mode when not in any other power mode. During this mode, AverageCurrent(), Voltage() and Temperature() measurements are taken, and the interface data set is updated. Decisions to change states are also made. This mode is exited by activating a different power mode.

Because the gauge consumes the most power in NORMAL mode, the Impedance Track™ algorithm minimizes the time the fuel gauge remains in this mode.



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5.7.3 SLEEP Mode

SLEEP mode is entered automatically if the feature is enabled (Operation Configuration [SLEEP] = 1) and AverageCurrent() is below the programmable level Sleep Current. Once entry into SLEEP mode has been qualified, but prior to entering it, the bq27520-G3 performs an coulomb counter autocalibration to minimize offset.

During SLEEP mode, the bq27520-G3 periodically takes data measurements and updates its data set. However, a majority of its time is spent in an idle condition.

The bq27520-G3 exits SLEEP if any entry condition is broken, specifically when (1) AverageCurrent() rises above **Sleep Current**, or (2) a current in excess of I_{WAKF} through R_{SFNSF} is detected.

In the event that a battery is removed from the system while a charger is present (and powering the gauge), Impedance Track™ updates are not necessary. Hence, the fuel gauge enters a state that checks for battery insertion and does not continue executing the Impedance Track™ algorithm.

5.7.4 SLEEP+ Mode

Compared to the SLEEP mode, SLEEP+ mode has the high frequency oscillator in operation, hence the communication delay associated with waking up from SLEEP mode can be eliminated. The SLEEP+ is entered automatically if the feature is enabled (CONTROL STATUS [SNOOZE] = 1) and AverageCurrent() is below the programmable level Sleep Current.

During SLEEP+ mode, the bq27520-G3 periodically takes data measurements and updates its data set. However, a majority of its time is spent in an idle condition.

The bq27520-G3 exits SLEEP+ if any entry condition is broken, specifically when (1) any communication activity with the gauge, or (2) AverageCurrent() rises above Sleep Current, or (3) a current in excess of I_{WAKE} through R_{SENSE} is detected.

5.7.5 HIBERNATE Mode

HIBERNATE mode should be used when the system equipment needs to enter a low-power state, and minimal gauge power consumption is required. This mode is ideal when a system equipment is set to its own HIBERNATE, SHUTDOWN, or OFF modes.

Before the fuel gauge can enter HIBERNATE mode, the system must set the [HIBERNATE] bit of the CONTROL STATUS register. The gauge waits to enter HIBERNATE mode until it has taken a valid OCV measurement and the magnitude of the average cell current has fallen below Hibernate Current. The gauge can also enter HIBERNATE mode if the cell voltage falls below Hibernate Voltage and a valid OCV measurement has been taken. The gauge will remain in HIBERNATE mode until the system issues a direct I²C command to the gauge or a POR occurs. I²C Communication that is not directed to the gauge will not wake the gauge.

It is important that BAT GD be de-asserted status (no battery charging/discharging). This prevents a charger application from inadvertently charging the battery before an OCV reading can be taken. It is the system's responsibility to wake the bq27520-G3 after it has gone into HIBERNATE mode. After waking, the gauge can proceed with the initialization of the battery information (OCV, profile selection, etc.)

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5.8 Power Control

5.8.1 Wake-Up Comparator

The wake-up comparator is used to indicate a change in cell current while the bq27520-G3 is in SLEEP mode. *Operation Configuration* uses bits *[RSNS1–RSNS0]* to set the sense resistor selection. *Operation Configuration* also uses the *[IWAKE]* bit to select one of two possible voltage threshold ranges for the given sense resistor selection. An internal interrupt is generated when the threshold is breached in either the charge or discharge direction. Setting both *[RSNS1]* and *[RSNS0]* to 0 disables this feature.

| | | | _ |
|-------|-------|-------|-------------------|
| RSNS1 | RSNS0 | IWAKE | Vth(SRP-SRN) |
| 0 | 0 | 0 | Disabled |
| 0 | 0 | 1 | Disabled |
| 0 | 1 | 0 | 1.0 mV or –1.0 mV |
| 0 | 1 | 1 | 2.2 mV or –2.2 mV |
| 1 | 0 | 0 | 2.2 mV or –2.2 mV |
| 1 | 0 | 1 | 4.6 mV or –4.6 mV |
| 1 | 1 | 0 | 4.6 mV or –4.6 mV |
| 1 | 1 | 1 | 9.8 mV or –9.8 mV |

Table 5-9. I_{WAKE} Threshold Settings⁽¹⁾

5.8.2 Flash Updates

Data Flash can only be updated if $Voltage() \ge Flash Update OK Voltage$. Flash programming current can cause an increase in LDO dropout. The value of *Flash Update OK Voltage* should be selected such that the bq27520-G3 V_{CC} voltage does not fall below its minimum of 2.4 V during Flash write operations.

5.9 Autocalibration

The bq27520-G3 provides an autocalibration feature that measures the voltage offset error across SRP and SRN as operating conditions change. It subtracts the resulting offset error from normal sense resistor voltage, V_{SR} , for maximum measurement accuracy.

Autocalibration of the coulomb counter begins on entry to SLEEP mode, except if Temperature() is $\leq 5^{\circ}C$ or $Temperature() \geq 45^{\circ}C$.

The fuel gauge also performs a single offset when (1) the condition of $AverageCurrent() \le 100$ mA and (2) {voltage change since last offset calibration ≥ 256 mV} or {temperature change since last offset calibration is greater than 8°C for ≥ 60 s}.

Capacity and current measurements continue at the last measured rate during the offset calibration when these measurements cannot be performed. If the battery voltage drops more than 32 mV during the offset calibration, the load current has likely increased; hence, the offset calibration is aborted.

⁽¹⁾ The actual resistance value vs the setting of the sense resistor is not important, just the actual voltage threshold when calculating the configuration. The voltage thresholds are typical values under room temperature.

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6 APPLICATION-SPECIFIC INFORMATION

6.1 Battery Profile Storage and Selection

6.1.1 Common Profile Aspects

The bq27520-G3 supports only one type of battery profile. This profile is stored in both the **Def0** and **Def1** profiles. When a battery pack is inserted for the first time, the default profile is copied into the **Packn** profiles. Then the Impedance $Track^{TM}$ algorithm begins gas gauging, regularly updating **Packn** as the battery is used.

In addition to the default profiles, the fuel gauge maintains two profiles PACK0 and PACK1. These tables hold dynamic battery data, and keep track of the status for up to two of the most recent batteries used. In most cases, the fuel gauge can manage the information on two removable battery packs. When a battery pack is removed from host equipment, the bq27520-G3 maintains some of the battery information in case the battery is re-inserted. This way, the Impedance TrackTM algorithm has a means of recovering battery-status information, thereby maintaining good state-of-charge (SOC) estimates.

When an existing pack is removed from the bq27520-G3 and a different (or same) pack is inserted, cell impedance is measured immediately after battery detection (see Section 6.1.2.1, First OCV and Impedance Measurement). The bq27520-G3 chooses the profile which is closest to the measured impedance, starting with the **Packn** profiles. That is, if the measured impedance matches **Pack1** profile is used. If the measured impedance matches **Pack1**, then the **Pack1** profile is used. If the measured impedance stored in either **Pack0** or **Pack1**, the battery pack is deemed new (none of the previously used packs). Either **Def0/Def1** profile is copied into either the **Pack0** or **Pack1** profile, overwriting the oldest **Packn** profile.

6.1.2 Activities Upon Pack Insertion

6.1.2.1 First OCV and Impedance Measurement

At power-up the $\overline{BAT_GD}$ pin is inactive, so that the system might not obtain power from the battery (this depends on actual implementation). In this state, the battery should be put in a condition with load current less than C/20. Next, the bq27520-G3 measures its first open-circuit voltage (OCV) via the BAT pin. The [OCVCMDCOMP] bit will set once the OCV measurement is completed. Depending on the load current, the [OCVFAIL] bit indicates whether the OCV reading is valid. From the OCV(SOC) table, the SOC of the inserted battery is found. Then the $\overline{BAT_GD}$ pin is made active, and the impedance of the inserted battery is calculated from the measured voltage and the load current: Z(SOC) = (OCV(SOC) - V) / I. This impedance is compared with the impedance of the dynamic profiles, **Packn**, and the default profiles, **Defn**, for the same SOC (the letter **n** depicts either a **0** or **1**). The [INITCOMP] bit will be set afterwards and the OCV command could be issued

6.1.3 Reading Application Status

The *Application Status* data flash location contains cell profile status information, and can be read using the *ApplicationStatus()* extended command (0x6a). The bit configuration of this function/location is shown in Table 6-1.

Table 6-1. ApplicationStatus() Bit Definitions.

| Application Configuration | bit7 | bit6 | bit5 | bit4 | bit3 | bit2 | bit1 | bit0 |
|---------------------------|------|------|------|------|------|------|------|----------|
| Byte | _ | _ | _ | _ | _ | _ | _ | LU_ PROF |

LU_PROF = Last profile used by fuel gauge. Cell0 last used when cleared. Cell1 last used when set. Default is 0.

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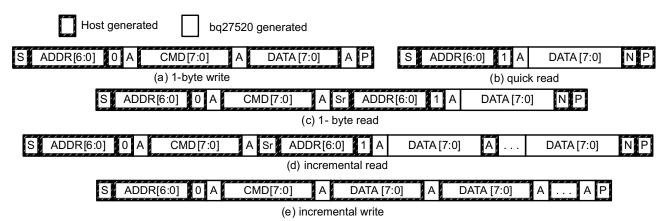
TEXAS INSTRUMENTS

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7 COMMUNICATIONS

7.1 I²C Interface

The bq27520-G3 supports the standard I²C read, incremental read, quick read, one byte write, and incremental write functions. The 7-bit device address (ADDR) is the most significant 7 bits of the hex address and is fixed as 1010101. The first 8-bits of the I²C protocol will; therefore, be 0xAA or 0xAB for write or read, respectively.

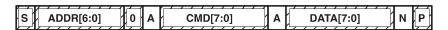


(S = Start, Sr = Repeated Start, A = Acknowledge, N = No Acknowledge, and P = Stop).

The "quick read" returns data at the address indicated by the address pointer. The address pointer, a register internal to the I²C communication engine, will increment whenever data is acknowledged by the bq27520-G3 or the I²C master. "Quick writes" function in the same manner and are a convenient means of sending multiple bytes to consecutive command locations (such as two-byte commands that require two bytes of data)

The following command sequences are not supported:

Attempt to write a read-only address (NACK after data sent by master):



Attempt to read an address above 0x6B (NACK command):



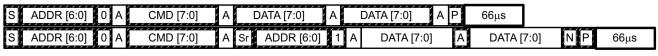
7.2 I2C Time Out

The I^2C engine will release both SDA and SCL if the I^2C bus is held low for the time defined by \emph{FC} *Timeout* times 0.5 second. If the bq27520-G3 was holding the lines, releasing them will free them for the master to drive the lines. If an external condition is holding either of the lines low, the I^2C engine will enter the low power sleep mode.

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7.3 I²C Command Waiting Time

To make sure the correct results of a command with the 400-kHz I²C operation, a proper waiting time should be added between issuing command and reading results. For subcommands, the following diagram shows the waiting time required between issuing the control command the reading the status with the exception of checksum and OCV commands. A 100ms waiting time is required between the checksum command and reading result, and a 1.2-second waiting time is required between the OCV command and result. For read-write standard command, a minimum of 2 seconds is required to get the result updated. For read-only standard commands, there is no waiting time required, but the host should not issue all standard commands more than two times per second. Otherwise, the gauge could result in a reset issue due to the expiration of the watchdog timer.



Waiting time between control subcommand and reading results



Waiting time between continuous reading results

7.4 I²C Clock Stretching

I²C clock stretches can occur during all modes of fuel gauge operation. In the SLEEP and HIBERNATE modes, a short clock stretch will occur on all I²C traffic as the device must wake-up to process the packet. In NORMAL and SLEEP+ modes, clock stretching will only occur for packets addressed for the fuel gauge. The timing of stretches will vary as interactions between the communicating host and the gauge are asynchronous. The I²C clock stretches may occur after start bits, the ACK/NAK bit and first data bit transmit on a host read cycle. The majority of clock stretch periods are small (≤ 4 ms) as the I²C interface peripheral and CPU firmware perform normal data flow control. However, less frequent but more significant clock stretch periods may occur when data flash (DF) is being written by the CPU to update the resistance (Ra) tables and other DF parameters such as Qmax. Due to the organization of DF, updates need to be written in data blocks consisting of multiple data bytes.

An Ra table update requires erasing a single page of DF, programming the updated Ra table and a flag. The potential I²C clock stretching time is 24 ms maximum. This includes 20ms page erase and 2ms row programming time (x2 rows). The Ra table updates occur during the discharge cycle and at up to 15 resistance grid points that occur during the discharge cycle.

A DF block write typically requires a max of 72ms. This includes copying data to a temporary buffer and updating DF. This temporary buffer mechanism is used to protect from power failure during a DF update. The first part of the update requires 20ms time to erase the copy buffer page, 6 ms time to write the data into the copy buffer and the program progress indicator (2ms for each individual write). The second part of the update is writing to the DF and requires 44ms DF block update time. This includes a 20ms each page erase for two pages and 2ms each row write for two rows.

In the event that a previous DF write was interrupted by a power failure or reset during the DF write, an additional 44ms max DF restore time is required to recover the data from a previously interrupted DF write. In this power failure recovery case, the total I²C clock stretching is 116ms max.

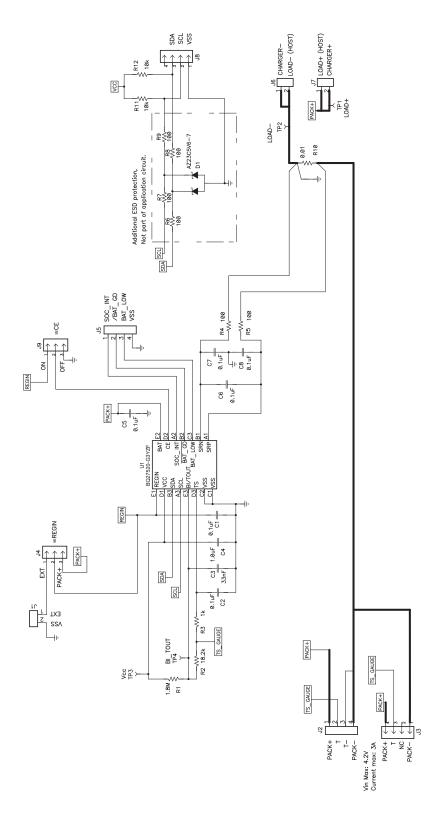
Another case where I^2C clock stretches is at the end of discharge. The update to the last discharge data will go through the DF block update twice because two pages are used for the data storage. The clock stretching in this case is 144ms max. This occurs if there has been a Ra table update during the discharge.



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8 REFERENCE SCHEMATICS

8.1 Schematic





bq27520-G3

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8.2 Package Dimensions

| D | E |
|---------------|---------------|
| Max = 2640 μm | Max = 1986 μm |
| Min = 2580 μm | Min = 1926 μm |



PACKAGE OPTION ADDENDUM

24-Aug-2018

PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|----------------------|---------|
| BQ27520YZFR-G3 | LIFEBUY | DSBGA | YZF | 15 | 3000 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | BQ27520 | |
| BQ27520YZFT-G3 | LIFEBUY | DSBGA | YZF | 15 | 250 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | BQ27520 | |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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24-Aug-2018

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| Α0 | Dimension designed to accommodate the component width |
|----|---|
| | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| BQ27520YZFR-G3 | DSBGA | YZF | 15 | 3000 | 180.0 | 8.4 | 2.1 | 2.76 | 0.81 | 4.0 | 8.0 | Q1 |
| BQ27520YZFT-G3 | DSBGA | YZF | 15 | 250 | 180.0 | 8.4 | 2.1 | 2.76 | 0.81 | 4.0 | 8.0 | Q1 |

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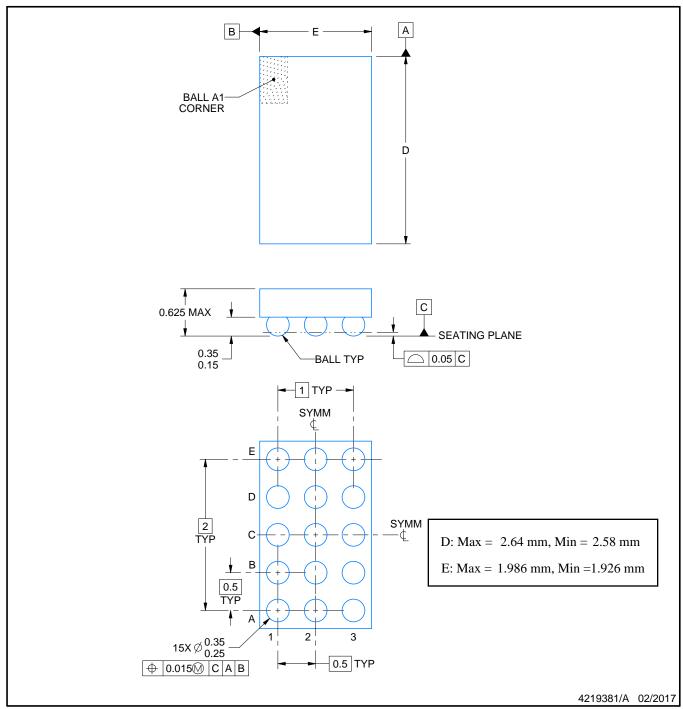


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) | |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|--|
| BQ27520YZFR-G3 | DSBGA | YZF | 15 | 3000 | 182.0 | 182.0 | 20.0 | |
| BQ27520YZFT-G3 | DSBGA | YZF | 15 | 250 | 182.0 | 182.0 | 20.0 | |



DIE SIZE BALL GRID ARRAY



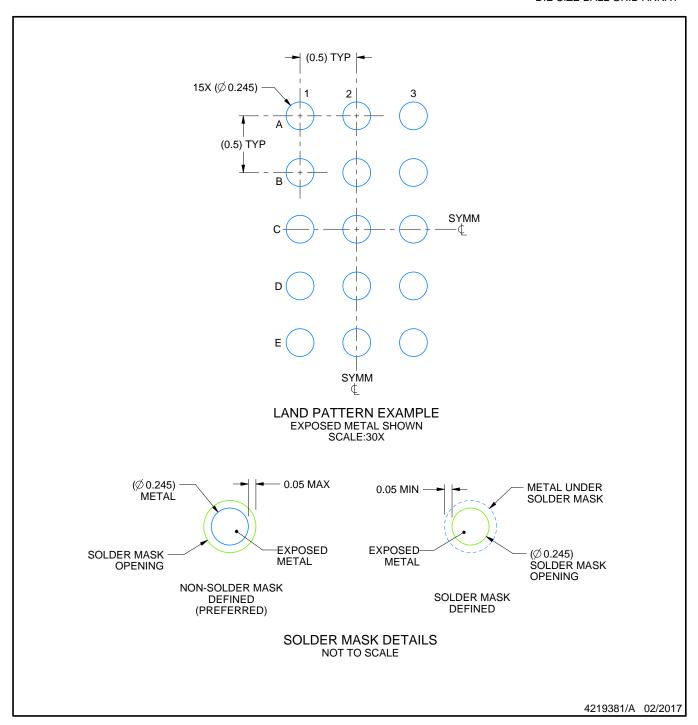
NOTES:

NanoFree Is a trademark of Texas Instruments.

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
- 3. NanoFree[™] package configuration.



DIE SIZE BALL GRID ARRAY

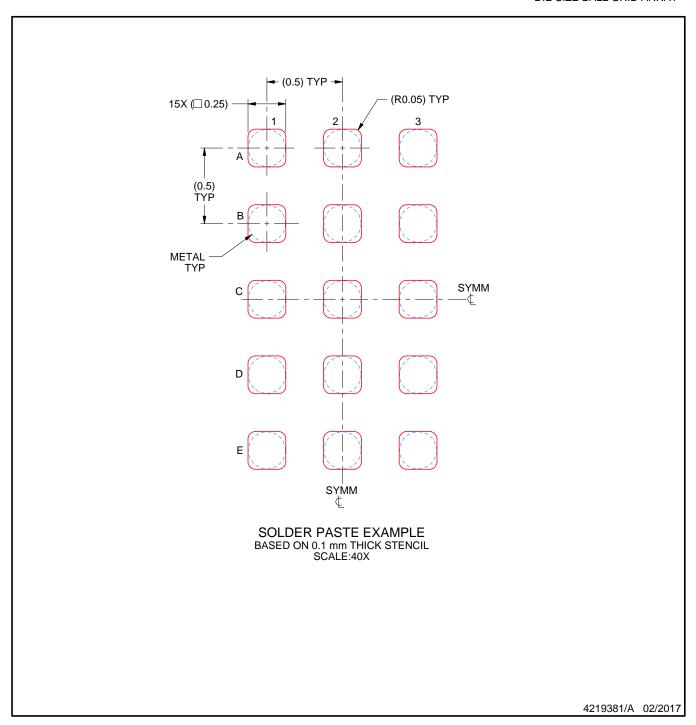


NOTES: (continued)

4. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).



DIE SIZE BALL GRID ARRAY



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



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